



# LP3972 Power Management Unit for Advanced Application Processors

## 1 Features

- Compatible With Advanced Applications Processors Requiring Dynamic Voltage Management (DVM)
- Backup Battery Charger With Automatic Switch for Lithium-Manganese Coin-Cell Batteries and Super Capacitors
- I<sup>2</sup>C-Compatible High-Speed Serial Interface
- Software Control of Regulator Functions and Settings
- Thermal and Current Overload Protections
- Three Buck Regulators for Powering High-Current Processor Functions or I/Os
  - Programmable V<sub>OUT</sub> from 0.725 V to 3.3 V
  - Up to 95% Efficiency and 1.6-A Output Current
  - ±3% Output Voltage Accuracy
- Six LDOs for Powering RTC, Peripherals, and I/Os
  - Programmable V<sub>OUT</sub> of 1 V to 3.3 V
  - ±3% Output Voltage Accuracy
    - LDO\_RTC 30 mA
    - LDO1 300 mA
    - LDO2 150 mA
    - LDO3 150 mA
    - LDO4 150 mA
    - LDO5 400 mA

## 2 Applications

- Smart Phones
- Personal Media Players
- Digital Cameras
- Application Processors
  - Marvell PXA
  - Freescale
  - Samsung

## 3 Description

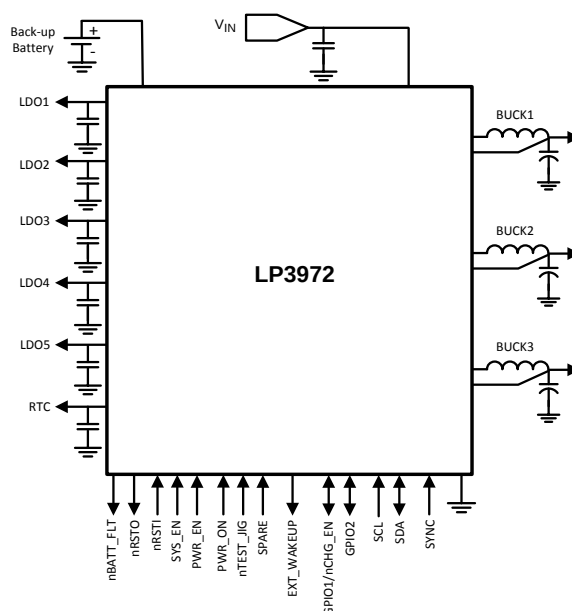
The LP3972 is a multi-function programmable power management unit (PMU) designed especially for advanced application processors. The LP3972 is optimized for low-power handheld applications and provides six low-dropout low-noise linear regulators, three DC-DC magnetic buck regulators, a backup battery charger, and two GPIOs. A high-speed serial interface is included to program individual regulator output voltages as well as on and off control.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |
|-------------|-----------|-------------------|
| LP3972      | WQFN (40) | 5.00 mm × 5.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Simplified Schematic



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision K (May 2013) to Revision L                                                                                                                                                                                                                                                                                                                                                                                                                            | Page     |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------|
| <ul style="list-style-type: none"> <li>Added <i>Device Information</i> and <i>Pin Configuration and Functions</i> sections, <i>ESD Ratings</i> and <i>Thermal Information</i> tables, <i>Feature Description</i>, <i>Device Functional Modes</i>, <i>Application and Implementation</i>, <i>Power Supply Recommendations</i>, <i>Layout</i>, <i>Device and Documentation Support</i>, and <i>Mechanical, Packaging, and Orderable Information</i> sections .....</li> </ul> | <b>1</b> |

| Changes from Revision J (May 2013) to Revision K                                                           | Page      |
|------------------------------------------------------------------------------------------------------------|-----------|
| <ul style="list-style-type: none"> <li>Changed layout of National Data Sheet to TI format .....</li> </ul> | <b>55</b> |

## 5 Device Comparison Tables

**Table 1. Supply Specifications**

| SUPPLY                   | $V_{OUT}$ (V) <sup>(1)(2)</sup> |            | $I_{MAX}$ : MAXIMUM CURRENT         |
|--------------------------|---------------------------------|------------|-------------------------------------|
|                          | RANGE                           | RESOLUTION | CURRENT (mA)                        |
|                          | (V)                             | (mV)       |                                     |
| LDO_RTC                  | 2.8                             | N/A        | 30-mA DC source 10-mA backup source |
| LDO1 ( $V_{CC\_MVT}$ )   | 1.7 to 2                        | 25         | 300                                 |
| LDO2                     | 1.8 to 3.3                      | 100        | 150                                 |
| LDO3                     | 1.8 to 3.3                      | 100        | 150                                 |
| LDO4                     | 1.0 to 3.3                      | 50 - 600   | 150                                 |
| LDO5 ( $V_{CC\_SRAM}$ )  | 0.850 to 1.5                    | 25         | 400                                 |
| BUCK1 ( $V_{CC\_APPS}$ ) | 0.725 to 1.5                    | 25         | 1600                                |
| BUCK2                    | 0.8 to 3.3                      | 50 - 600   | 1600                                |
| BUCK3                    | 0.8 to 3.3                      | 50 - 600   | 1600                                |

(1) All voltages are with respect to the potential at the GND pin.

(2) The human body model is a 100-pF capacitor discharged through a 1.5-k $\Omega$  resistor into each pin. (MIL-STD-883 3015.7) The machine model is a 200-pF capacitor discharged directly into each pin. (EAIJ).

**Table 2. Default Voltage Options <sup>(1)(2)(3)</sup>**

| VERSION | LP3972SQ-A514 |           | LP3972SQ-A413 |           |
|---------|---------------|-----------|---------------|-----------|
| Enable  | Version A     |           | Version A     |           |
| LDO_RTC | —             | 2.8 V     | —             | 2.8 V     |
| LDO1    | SYS_EN        | 1.8 V     | SYS_EN        | 1.8 V     |
| LDO2    | SYS_EN        | 1.8 V (D) | SYS_EN        | 1.8 V (D) |
| LDO3    | SYS_EN        | 3 V (D)   | SYS_EN        | 3 V (D)   |
| LDO4    | SYS_EN        | 3 V (D)   | SYS_EN        | 2.8 V (D) |
| LDO5    | PWR_EN        | 1.4 V     | PWR_EN        | 1.4 V     |
| BUCK1   | PWR_EN        | 1.4 V     | PWR_EN        | 1.4 V     |
| BUCK2   | SYS_EN        | 3.3 V     | SYS_EN        | 3 V       |
| BUCK3   | SYS_EN        | 1.8 V     | SYS_EN        | 1.8 V     |
| VERSION | P3972SQ-E514  |           | LP3972SQ-I514 |           |
| Enable  | Version E     |           | Version I     |           |
| LDO_RTC | —             | 2.8 V     | —             | 2.8 V     |
| LDO1    | SYS_EN        | 1.8 V     | SYS_EN        | 1.8 V     |
| LDO2    | SYS_EN        | 1.8 V (E) | SYS_EN        | 1.8 V (E) |
| LDO3    | SYS_EN        | 3 V (D)   | SYS_EN        | 3 V (E)   |
| LDO4    | SYS_EN        | 3 V (D)   | SYS_EN        | 3 V (E)   |
| LDO5    | PWR_EN        | 1.4 V     | PWR_EN        | 1.4 V     |
| BUCK1   | PWR_EN        | 1.4 V     | PWR_EN        | 1.4 V     |
| BUCK2   | SYS_EN        | 3.3 V     | SYS_EN        | 3.3 V     |
| BUCK3   | SYS_EN        | 1.8 V     | SYS_EN        | 1.8 V     |

(1) All voltages are with respect to the potential at the GND pin

(2) The human body model is a 100-pF capacitor discharged through a 1.5-k $\Omega$  resistor into each pin. (MIL-STD-883 3015.7) The machine model is a 200-pF capacitor discharged directly into each pin. (EAIJ).

(3) E = Regulator is ENABLED during start-up. D = Regulator is DISABLED during start-up.

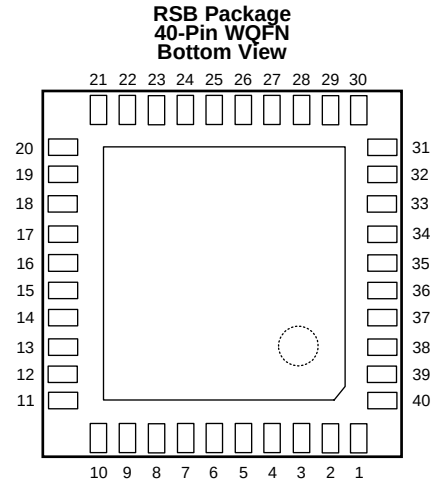
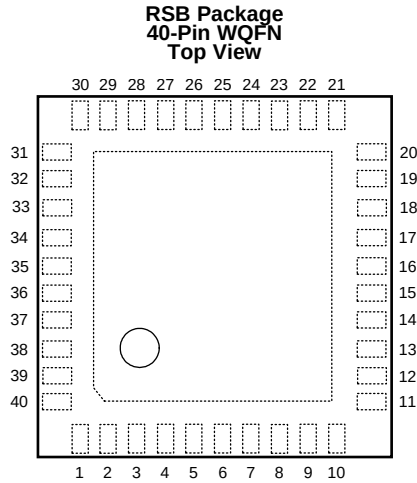
**LP3972**

SNVS468L –SEPTEMBER 2006–REVISED NOVEMBER 2015

[www.ti.com](http://www.ti.com)
**Table 2. Default Voltage Options<sup>(1)(2)(3)</sup> (continued)**

| VERSION | LP3972SQ-I414 |           | LP3972SQ-0514    |                   |
|---------|---------------|-----------|------------------|-------------------|
| Enable  | Version I     |           | Version 0        |                   |
| LDO_RTC | —             | 2.8 V     | Tracking enabled | 3.3 V w/ tracking |
| LDO1    | SYS_EN        | 1.8 V     | SYS_EN           | 1.8 V             |
| LDO2    | SYS_EN        | 1.8 V (E) | SYS_EN           | 1.8 V (E)         |
| LDO3    | SYS_EN        | 3 V (E)   | SYS_EN           | 3.3 V (E)         |
| LDO4    | SYS_EN        | 3 V (E)   | SYS_EN           | 3 V (E)           |
| LDO5    | PWR_EN        | 1.4 V     | PWR_EN           | 1.4 V             |
| BUCK1   | PWR_EN        | 1.4 V     | PWR_EN           | 1.4 V             |
| BUCK2   | SYS_EN        | 3 V       | SYS_EN           | 3.3 V             |
| BUCK3   | SYS_EN        | 1.8 V     | SY_EN            | 1.8 V             |
| VERSION | LP3972SQ-5810 |           |                  |                   |
| Enable  | Version 5     |           |                  |                   |
| LDO_RTC | —             | 2.8 V     |                  |                   |
| LDO1    | SYS_EN        | 1.8 V     |                  |                   |
| LDO2    | SYS_EN        | 1.8 V (E) |                  |                   |
| LDO3    | SYS_EN        | 2.5 V (E) |                  |                   |
| LDO4    | PWR_EN        | 1.3 V (E) |                  |                   |
| LDO5    | PWR_EN        | 1.1 V     |                  |                   |
| BUCK1   | PWR_EN        | 1.35 V    |                  |                   |
| BUCK2   | SYS_EN        | 1.2 V     |                  |                   |
| BUCK3   | SYS_EN        | 1.8 V     |                  |                   |

## 6 Pin Configuration and Functions



### Pin Functions

| PIN    |                     | I/O | TYPE <sup>(1)</sup> | DESCRIPTION                                                                                                                                                                                                                                                              |
|--------|---------------------|-----|---------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NUMBER | NAME <sup>(2)</sup> |     |                     |                                                                                                                                                                                                                                                                          |
| 1      | PWR_ON              | I   | D                   | This is an active HI push button input which can be used to signal PWR_ON and PWR_OFF events to the CPU by controlling the EXT_WAKEUP [pin4] and select contents of register 8H'88.                                                                                      |
| 2      | nTEST_JIG           | I   | D                   | This is an active LOW input signal used for detecting an external HW event. The response is seen in the EXT_WAKEUP [pin4] and select contents of register 8H'88.                                                                                                         |
| 3      | SPARE               | I   | D                   | This is an input signal used for detecting a external HW event. The response is seen in the EXT_WAKEUP [pin4] and select contents of register 8H'88. The polarity on this pin is assignable.                                                                             |
| 4      | EXT_WAKEUP          | O   | D                   | This pin generates a single 10-ms pulse output to CPU in response to input from pins 1, 2, and 3. Flags CPU to interrogate register 8H'88.                                                                                                                               |
| 5      | FB1                 | I   | A                   | Buck1 input feedback pin.                                                                                                                                                                                                                                                |
| 6      | V <sub>IN</sub>     | I   | PWR                 | Battery input (internal circuitry and LDO1-3 power input)                                                                                                                                                                                                                |
| 7      | VOUT LDO1           | O   | PWR                 | LDO1 output                                                                                                                                                                                                                                                              |
| 8      | VOUT LDO2           | O   | PWR                 | LDO2 output                                                                                                                                                                                                                                                              |
| 9      | nRSTI               | I   | D                   | Active low reset pin. Signal used to reset the device (by default is pulled high internally). Typically a push button reset.                                                                                                                                             |
| 10     | GND1                | G   | G                   | Ground                                                                                                                                                                                                                                                                   |
| 11     | VREF                | O   | A                   | Bypass capacitor for the high internal impedance reference.                                                                                                                                                                                                              |
| 12     | VOUT LDO3           | O   | PWR                 | LDO3 output                                                                                                                                                                                                                                                              |
| 13     | VOUT LDO4           | O   | PWR                 | LDO4 output                                                                                                                                                                                                                                                              |
| 14     | VIN LDO4            | I   | PWR                 | Power input to LDO4 — this can be connected to either from a 1.8-V supply to main battery supply.                                                                                                                                                                        |
| 15     | VIN BUBATT          | I   | PWR                 | Backup battery input supply.                                                                                                                                                                                                                                             |
| 16     | VOUT LDO_RTC        | O   | PWR                 | LDO_RTC output supply to the RTC of the application processor.                                                                                                                                                                                                           |
| 17     | nBATT_FLT           | O   | D                   | Main battery fault output, indicates the main battery is low (discharged) or the DC source has been removed from the system. This gives the processor an indicator that the power will shut down. During this time the processor will operate from the backup coin cell. |
| 18     | PGND2               | G   | G                   | Buck2 NMOS power ground                                                                                                                                                                                                                                                  |
| 19     | SW2                 | O   | PWR                 | Buck2 switcher output                                                                                                                                                                                                                                                    |

(1) A: Analog Pin D: Digital Pin G: Ground Pin P: Power Pin I: Input Pin I/O: Input/Output Pin O: Output Pin

(2) In this document, active-low logic items are prefixed with a lowercase "n".

**Pin Functions (continued)**

| PIN    |                     | I/O | TYPE <sup>(1)</sup> | DESCRIPTION                                                                                                                                                                                                                                                                   |
|--------|---------------------|-----|---------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NUMBER | NAME <sup>(2)</sup> |     |                     |                                                                                                                                                                                                                                                                               |
| 20     | VIN BUCK2           | I   | PWR                 | Battery input power to Buck2                                                                                                                                                                                                                                                  |
| 21     | SDA                 | I/O | D                   | I <sup>2</sup> C Data (Bidirectional)                                                                                                                                                                                                                                         |
| 22     | SCL                 | I   | D                   | I <sup>2</sup> C Clock                                                                                                                                                                                                                                                        |
| 23     | FB2                 | I   | A                   | Buck2 input feedback pin                                                                                                                                                                                                                                                      |
| 24     | nRSTO               | O   | D                   | Reset output from the PMIC to the processor                                                                                                                                                                                                                                   |
| 25     | VOUT LDO5           | O   | PWR                 | LDO5 output                                                                                                                                                                                                                                                                   |
| 26     | VIN LDO5            | I   | PWR                 | Power input to LDO5, this can be connected to V <sub>IN</sub> or to a separate 1.8-V supply.                                                                                                                                                                                  |
| 27     | VDDA                | I   | PWR                 | Analog Power for VREF, BIAS                                                                                                                                                                                                                                                   |
| 28     | FB3                 | I   | A                   | Buck3 Feedback                                                                                                                                                                                                                                                                |
| 29     | GPIO1 /<br>nCHG_EN  | I/O | D                   | General purpose I/O / Ext. backup battery charger enable pin. This pin enables the main battery or DC source power to charge the backup battery. This pin toggled via the application processor. By grounding this pin the DC source continuously charges the backup battery. |
| 30     | GPIO2               | I/O | D                   | General purpose I/O                                                                                                                                                                                                                                                           |
| 31     | VIN BUCK3           | I   | PWR                 | Battery input power to Buck3                                                                                                                                                                                                                                                  |
| 32     | SW3                 | O   | PWR                 | Buck3 switcher output                                                                                                                                                                                                                                                         |
| 33     | PGND3               | G   | G                   | Buck3 NMOS Power ground                                                                                                                                                                                                                                                       |
| 34     | BGND1,2,3           | G   | G                   | Bucks 1, 2 and 3 analog ground                                                                                                                                                                                                                                                |
| 35     | SYNC                | I   | D                   | Frequency synchronization: Connection to an external clock signal PLL to synchronize the PMIC internal oscillator.                                                                                                                                                            |
| 36     | SYS_EN              | I   | D                   | Input digital enable pin for the high voltage power domain supplies. Output from the Monahans processor.                                                                                                                                                                      |
| 37     | PWR_EN              | I   | D                   | Digital enable pin for the low-voltage domain supplies. Output signal from the Monahans processor                                                                                                                                                                             |
| 38     | PGND1               | G   | G                   | Buck1 NMOS power ground                                                                                                                                                                                                                                                       |
| 39     | SW1                 | O   | PWR                 | Buck1 switcher output                                                                                                                                                                                                                                                         |
| 40     | VIN BUCK1           | I   | PWR                 | Battery input power to Buck1                                                                                                                                                                                                                                                  |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

|                                                                 | MIN  | MAX | UNIT |
|-----------------------------------------------------------------|------|-----|------|
| All inputs                                                      | −0.3 | 6.5 | V    |
| GND-to-GND SLUG                                                 | −0.3 | 0.3 | V    |
| Junction temperature, $T_{J-MAX}$                               |      | 150 | °C   |
| Power dissipation ( $T_A = 70^{\circ}\text{C}$ ) <sup>(3)</sup> |      | 3.2 | W    |
| Maximum lead temperature (soldering)                            |      | 260 | °C   |
| Storage temperature, $T_{stg}$                                  | −65  | 150 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) If Military/Aerospace specified devices are required, contact the TI Sales Office/Distributors for availability and specifications.
- (3) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ( $T_{A-MAX}$ ) is dependent on the maximum operating junction temperature ( $T_{J-MAX-OP} = 125^{\circ}\text{C}$ ), the maximum power dissipation of the device in the application ( $P_{D-MAX}$ ), and the junction-to ambient thermal resistance of the part/package in the application ( $R_{\theta JA}$ ), as given by the following equation:  $T_{A-MAX} = T_{J-MAX-OP} - (R_{\theta JA} \times P_{D-MAX})$ .

### 7.2 ESD Ratings

|                                     |                                                                   | VALUE | UNIT |
|-------------------------------------|-------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | ±2000 | V    |
|                                     | Machine model                                                     | ±200  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                                                                               | MIN  | NOM | MAX      | UNIT |
|-------------------------------------------------------------------------------|------|-----|----------|------|
| $V_{IN}$                                                                      | 2.7  |     | 5.5      | V    |
| $V_{INLDO4, 5}$                                                               | 1.74 |     | $V_{IN}$ | V    |
| Junction temperature, $T_J$                                                   | −40  |     | 125      | °C   |
| Operating temperature, $T_A$                                                  | −40  |     | 85       | °C   |
| Maximum power dissipation ( $T_A = 70^{\circ}\text{C}$ ) <sup>(1)(2)(3)</sup> |      |     | 2.2      | W    |

- (1) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ( $T_{A-MAX}$ ) is dependent on the maximum operating junction temperature ( $T_{J-MAX-OP} = 125^{\circ}\text{C}$ ), the maximum power dissipation of the device in the application ( $P_{D-MAX}$ ), and the junction-to ambient thermal resistance of the part/package in the application ( $R_{\theta JA}$ ), as given by the following equation:  $T_{A-MAX} = T_{J-MAX-OP} - (R_{\theta JA} \times P_{D-MAX})$ .
- (2) Junction-to-ambient thermal resistance ( $R_{\theta JA}$ ) is taken from a thermal modeling result, performed under the conditions and guidelines set forth in the JEDEC standard JESD51–7. The test board is a 4-layer FR-4 board measuring 102 mm × 76 mm × 1.6 mm with a 2 × 1 array of thermal vias. The ground plane on the board is 50 mm × 50 mm. Thickness of copper layers are 36 μm/1.8 μm/18 μm/36 μm (1.5 oz/1 oz/1 oz/1.5 oz). Ambient temperature in simulation is 22°C, still air. Power dissipation is 1W. Junction-to-ambient thermal resistance is highly application and board-layout dependent. In applications where high maximum power dissipation exists, special care must be paid to thermal dissipation issues in board design. The value of  $R_{\theta JA}$  of this product can vary significantly, depending on PCB material, layout, and environmental conditions. In applications where high maximum power dissipation exists (high  $V_{IN}$ , high  $I_{OUT}$ ), special care must be paid to thermal dissipation issues. For more information on these topics, see Texas Instruments Application Note *Leadless Leadframe Package (LLP)*(SNOA401).
- (3) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ( $T_{A-MAX}$ ) is dependent on the maximum operating junction temperature ( $T_{J-MAX-OP} = 125^{\circ}\text{C}$ ), the maximum power dissipation of the device in the application ( $P_{D-MAX}$ ), and the junction-to ambient thermal resistance of the part/package in the application ( $R_{\theta JA}$ ), as given by the following equation:  $T_{A-MAX} = T_{J-MAX-OP} - (R_{\theta JA} \times P_{D-MAX})$ .

## 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup>                           | LP3972<br>RSB (WQFN)<br>40 PINS | UNIT |
|---------------------------------------------------------|---------------------------------|------|
|                                                         |                                 |      |
|                                                         |                                 |      |
| R <sub>θJA</sub> Junction-to-ambient thermal resistance | 25                              | °C/W |

- (1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report ([SPRA953](#)).

## 7.5 Electrical Characteristics

Typical values and limits apply for T<sub>J</sub> = 25°C; minimum and maximum limits apply over the entire junction temperature range for operation, –40°C to +125°C, unless otherwise specified. All voltages are with respect to the potential at the GND pin.<sup>(1)(2)</sup>

| PARAMETER                                                                | TEST CONDITIONS | MIN  | TYP | MAX             | UNIT |
|--------------------------------------------------------------------------|-----------------|------|-----|-----------------|------|
| V <sub>IN</sub> , VDDA, V <sub>IN</sub> bucks 1, 2 and 3 Battery voltage |                 | 2.7  | 3.6 | 5.5             | V    |
| V <sub>IN</sub> LDO4, V <sub>IN</sub> LDO5 Power supply for LDOs 4 and 5 |                 | 1.74 | 3.6 | V <sub>IN</sub> | V    |
| T <sub>SD</sub> Thermal shutdown <sup>(3)</sup>                          | Temperature     |      | 160 |                 | °C   |
|                                                                          | Hysteresis      |      | 20  |                 |      |

- (1) All limits specified at room temperature and at temperature extremes. All room temperature limits are production tested, ensured through statistical analysis or ensured by design. All limits at temperature extremes are ensured via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Input supply must not be higher than VDDA.
- (3) This electrical specification is ensured by design.

## 7.6 Electrical Characteristics: LDO RTC

V<sub>IN</sub> = 3.6 V, C<sub>IN</sub> = 1 μF, C<sub>OUT</sub> = 0.47 μF, C<sub>OUT</sub> (V<sub>RTC</sub>) = 1 μF ceramic (unless otherwise noted).

Typical values and limits apply for T<sub>J</sub> = 25°C; minimum and maximum limits apply over the entire junction temperature range for operation, –40°C to +125°C, unless otherwise specified. All voltages are with respect to the potential at the GND pin.<sup>(1)(2)(3)</sup>

| PARAMETER                                                      | TEST CONDITIONS                                                          | MIN                                                                                            | TYP | MAX   | UNIT |
|----------------------------------------------------------------|--------------------------------------------------------------------------|------------------------------------------------------------------------------------------------|-----|-------|------|
| V <sub>OUT</sub> accuracy Output voltage accuracy              | V <sub>IN</sub> connected, load current = 1 mA                           | 2.632                                                                                          | 2.8 | 2.968 | V    |
| ΔV <sub>OUT</sub>                                              | Line regulation                                                          | V <sub>IN</sub> = (V <sub>OUT(NOM)</sub> + 1 V) to 5.5 V <sup>(4)</sup><br>Load current = 1 mA |     | 0.15  | %/V  |
|                                                                | Load regulation                                                          | From main battery<br>Load current = 1 mA to 30 mA                                              |     | 0.05  | %mA  |
|                                                                |                                                                          | From backup battery, V <sub>IN</sub> = 3 V<br>Load current = 1 mA to 10 mA                     |     | 0.5   |      |
| I <sub>SC</sub> Short-circuit current limit                    | From main battery<br>V <sub>IN</sub> = V <sub>OUT</sub> + 0.3 V to 5.5 V |                                                                                                | 100 |       | mA   |
|                                                                | From backup battery                                                      |                                                                                                | 30  |       |      |
| V <sub>IN</sub> – V <sub>OUT</sub> Dropout voltage             | Load current = 10 mA                                                     |                                                                                                |     | 375   | mV   |
| I <sub>Q_MAX</sub> Maximum quiescent current                   | I <sub>OUT</sub> = 0 mA                                                  |                                                                                                | 30  |       | μA   |
| TP1 RTC LDO input switched from main battery to backup battery | V <sub>IN</sub> falling                                                  |                                                                                                | 2.9 |       | V    |
| TP2 RTC LDO input switched from backup battery to main battery | V <sub>IN</sub> rising                                                   |                                                                                                | 3   |       | V    |
| C <sub>OUT</sub> Output capacitor                              | Capacitance for stability                                                | 0.7                                                                                            | 1   |       | μF   |
|                                                                | ESR                                                                      | 5                                                                                              |     | 500   | mΩ   |

- (1) All limits specified at room temperature and at temperature extremes. All room temperature limits are production tested, ensured through statistical analysis or ensured by design. All limits at temperature extremes are ensured via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value.
- (3) LDO\_RTC voltage can track LDO3 voltage. LP3972 has a tracking function (nIO\_TRACK). When enabled, LDO\_RTC voltage tracks LDO3 voltage within 200 mV down to 2.8 V when LDO3 is enabled.
- (4) V<sub>IN</sub> minimum for line regulation values is 2.7 V for LDOs 1–3 and 1.8 V for LDOs 4 and 5. Condition does not apply to input voltages below the minimum input operating voltage.

## 7.7 Electrical Characteristics: LDOs 1 to 5

$V_{IN} = 3.6\text{ V}$ ,  $C_{IN} = 1\text{ }\mu\text{F}$ ,  $C_{OUT} = 0.47\text{ }\mu\text{F}$ ,  $C_{OUT}$  ( $V_{RTC}$ ) =  $1.0\text{ }\mu\text{F}$  ceramic (unless otherwise noted). Typical values and limits apply for  $T_J = 25^\circ\text{C}$ ; minimum and maximum limits apply over the entire junction temperature range for operation,  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ , unless otherwise specified. All voltages are with respect to the potential at the GND pin.<sup>(1)(2)(3)(4)(5)(6)</sup>

| PARAMETER          |                                              | TEST CONDITIONS                                                                | MIN  | TYP  | MAX   | UNIT          |
|--------------------|----------------------------------------------|--------------------------------------------------------------------------------|------|------|-------|---------------|
| $V_{OUT}$ accuracy | Output voltage accuracy (default $V_{OUT}$ ) | Load current = 1 mA                                                            | -3%  |      | 3%    |               |
| $\Delta V_{OUT}$   | Line regulation                              | $V_{IN} = 3.1\text{ V}$ to $5\text{ V}^{(7)}$ ,<br>Load Current = 1 mA         |      |      | 0.15  | %/V           |
|                    | Load regulation                              | $V_{IN} = 3.6\text{ V}$ ,<br>Load current = 1 mA to $I_{MAX}$                  |      |      | 0.011 | %/mA          |
| $I_{SC}$           | Short-circuit current limit                  | LDO1–4, $V_{OUT} = 0\text{ V}$                                                 |      | 400  |       | mA            |
|                    |                                              | LDO5, $V_{OUT} = 0\text{ V}$                                                   |      | 500  |       |               |
| $V_{IN} - V_{OUT}$ | Dropout voltage                              | Load current = 50 mA <sup>(8)</sup>                                            |      |      | 150   | mV            |
| PSRR               | Power Supply Ripple Rejection                | $f = 10\text{ kHz}$ , load current = $I_{MAX}$                                 |      | 45   |       | dB            |
| $I_Q$              | Quiescent current <i>On</i>                  | $I_{OUT} = 0\text{ mA}$                                                        |      | 40   |       | $\mu\text{A}$ |
|                    | Quiescent current <i>On</i>                  | $I_{OUT} = I_{MAX}$                                                            |      | 60   |       |               |
|                    | Quiescent current <i>Off</i>                 | EN is de-asserted                                                              |      | 0.03 |       |               |
| $T_{ON}$           | Turnon time                                  | Start-up from shutdown                                                         |      | 300  |       | $\mu\text{s}$ |
| $C_{OUT}$          | Output capacitor                             | Capacitance for stability<br>$0^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$ | 0.33 | 0.47 |       | $\mu\text{F}$ |
|                    |                                              | $-40^\circ\text{C} \leq T_J \leq 125^\circ\text{C}$                            | 0.68 | 1.0  |       |               |
|                    |                                              | ESR                                                                            | 5    |      | 500   | m $\Omega$    |

- (1) All limits specified at room temperature and are production tested, ensured through statistical analysis or ensured by design. All limits at temperature extremes are ensured via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value.
- (3) LDO\_RTC voltage can track LDO3 voltage. LP3972 has a tracking function (nIO\_TRACK). When enabled, LDO\_RTC voltage tracks LDO3 voltage within 200 mV down to 2.8 V when LDO3 is enabled.
- (4)  $V_{IN}$  minimum for line regulation values is 2.7 V for LDOs 1–3 and 1.8 V for LDOs 4 and 5. Condition does not apply to input voltages below the minimum input operating voltage.
- (5) An increase in the load current results in a slight decrease in the output voltage and vice versa.
- (6) Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification does not apply for input voltages below 2.7 V for LDOs 1 to 3 and 1.8 V for LDOs 4 and 5.
- (7)  $V_{IN}$  minimum for line regulation values is 2.7 V for LDOs 1–3 and 1.8 V for LDOs 4 and 5. Condition does not apply to input voltages below the minimum input operating voltage.
- (8) Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value.

## 7.8 Electrical Characteristics: Buck Converters SW1, SW2, SW3

$V_{IN} = 3.6\text{ V}$ ,  $C_{IN} = 10\text{ }\mu\text{F}$ ,  $C_{OUT} = 10\text{ }\mu\text{F}$ ,  $L_{OUT} = 2.2\text{-}\mu\text{H}$  ceramic (unless otherwise noted). Values and limits apply for  $T_J = 25^\circ\text{C}$ . All voltages are with respect to the potential at the GND pin.<sup>(1)(2)(3)</sup>

| PARAMETER        | TEST CONDITIONS               | MIN                                   | TYP  | MAX | UNIT          |
|------------------|-------------------------------|---------------------------------------|------|-----|---------------|
| $V_{OUT}$        | Output voltage accuracy       | Default $V_{OUT}$                     |      | –3% | 3%            |
| Eff              | Efficiency                    | Load current = 500 mA                 | 95%  |     |               |
| $I_{SHDN}$       | Shutdown supply current       | EN is de-asserted                     | 0.1  |     | $\mu\text{A}$ |
|                  | Sync mode clock frequency     | Synchronized from 13-MHz system clock | 10.4 | 13  | 15.6          |
| $f_{OSC}$        | Internal oscillator frequency |                                       | 2    |     | MHz           |
| $I_{PEAK}$       | Peak switching current limit  |                                       | 2.1  | 2.4 | A             |
| $I_Q$            | Quiescent current <i>On</i>   | No-load PFM mode                      | 21   |     | $\mu\text{A}$ |
|                  |                               | No-load PWM mode                      | 20   |     |               |
| $R_{DS(on)}$ (P) | Pin-pin resistance PFET       |                                       | 240  |     | m $\Omega$    |
| $R_{DS(on)}$ (N) | Pin-pin resistance NFET       |                                       | 200  |     | m $\Omega$    |
| $T_{ON}$         | Turnon time                   | Start-up from shutdown                | 500  |     | $\mu\text{s}$ |
| $C_{IN}$         | Input capacitor               | Capacitance for stability             | 8    |     | $\mu\text{F}$ |
| $C_{OUT}$        | Output capacitor              | Capacitance for stability             | 8    |     | $\mu\text{F}$ |

- (1) All limits specified at room temperature and at temperature extremes. All room temperature limits are production tested, ensured through statistical analysis or ensured by design. All limits at temperature extremes are ensured via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) The input voltage range recommended for ideal applications performance for the specified output voltages is  $V_{IN} = 2.7\text{ V}$  to  $5.5\text{ V}$  for  $0.8\text{ V} < V_{OUT} < 1.7\text{ V}$ ;  $V_{IN} = (V_{OUT} + 1\text{ V})$  to  $5.5\text{ V}$  for  $1.8\text{ V} \leq V_{OUT} \leq 3.3\text{ V}$ .
- (3) Test condition for  $V_{OUT} < 2.7\text{ V}$ ,  $V_{IN} = 3.6\text{ V}$ ; for  $V_{OUT} \geq 2.7\text{ V}$ ,  $V_{IN} = V_{OUT} + 1\text{ V}$ .

## 7.9 Electrical Characteristics: Backup Charger

$V_{IN} = V_{BATT} = 3.6\text{ V}$  (unless otherwise noted). Typical values and limits apply for  $T_J = 25^\circ\text{C}$ ; minimum and maximum limits apply over the entire junction temperature range for operation,  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ . All voltages are with respect to the potential at the GND pin.<sup>(1)(2)</sup>

| PARAMETER | TEST CONDITIONS                              | MIN                                                                                                                                               | TYP  | MAX | UNIT          |
|-----------|----------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|---------------|
| $V_{IN}$  | Operational voltage range                    | Voltage at $V_{IN}$                                                                                                                               | 3.3  | 5.5 | V             |
| $I_{OUT}$ | Backup battery charging current              | $V_{IN} = 3.6\text{ V}$ , Backup_Bat = 2.5 V<br>backup battery charger enabled                                                                    | 190  |     | $\mu\text{A}$ |
| $V_{OUT}$ | Charger termination voltage                  | $V_{IN} = 5\text{ V}$ , backup battery charger enabled;<br>programmable                                                                           | 2.91 | 3.1 | V             |
|           | Backup battery charger short circuit current | Backup_Bat = 0 V, backup battery charger enabled                                                                                                  | 9    |     | mA            |
| PSRR      | Power supply ripple rejection ratio          | $I_{OUT} \leq 50\text{ }\mu\text{A}$ , $V_{OUT} = 3.15\text{ V}$<br>$V_{OUT} + 0.4 \leq V_{BATT} = V_{IN} \leq 5\text{ V}$<br>$f < 10\text{ kHz}$ | 15   |     | dB            |
| $I_Q$     | Quiescent current                            | $I_{OUT} < 50\text{ }\mu\text{A}$                                                                                                                 | 25   |     | $\mu\text{A}$ |
| $C_{OUT}$ | Output capacitance                           | $0\text{ }\mu\text{A} \leq I_{OUT} \leq 100\text{ }\mu\text{A}$                                                                                   | 0.1  |     | $\mu\text{F}$ |
|           | Output capacitor ESR                         |                                                                                                                                                   | 5    | 500 | m $\Omega$    |

- (1) All limits specified at room temperature and at temperature extremes. All room temperature limits are production tested, ensured through statistical analysis or ensured by design. All limits at temperature extremes are ensured via correlation using standard Statistical Quality Control (SQC) methods. All limits are used to calculate Average Outgoing Quality Level (AOQL).
- (2) Backup battery charge current is programmable via the I<sup>2</sup>C-compatible interface.

## 7.10 Electrical Characteristics: I<sup>2</sup>C Compatible Serial Interface (SDA and SCL)

$V_{IN} = 3.6\text{ V}$  (unless otherwise noted). Typical values and limits appearing in normal type apply for  $T_J = 25^\circ\text{C}$ ; minimum and maximum limits apply over the entire junction temperature range for operation,  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ . All voltages are with respect to the potential at the GND pin.<sup>(1)(2)</sup>

| PARAMETER | TEST CONDITIONS          | MIN                           | TYP | MAX           | UNIT |
|-----------|--------------------------|-------------------------------|-----|---------------|------|
| $V_{IL}$  | Low level input voltage  | See <sup>(3)</sup>            |     | $0.3 V_{RTC}$ | V    |
| $V_{IH}$  | High level input voltage | See <sup>(3)</sup>            |     | $V_{RTC}$     |      |
| $V_{OL}$  | Low level output voltage | See <sup>(3)</sup>            |     | $0.2 V_{TRC}$ |      |
| $I_{OL}$  | Low level output current | $V_{OL} = 0.4\text{ V}^{(3)}$ |     |               | mA   |
| $F_{CLK}$ | Clock frequency          | See <sup>(3)</sup>            |     | 400           | kHz  |

(1) All limits specified at room temperature and are production tested, ensured through statistical analysis or ensured by design.

(2) The I<sup>2</sup>C signals behave like open-drain outputs and require an external pullup resistor on the system module in the 2-k $\Omega$  to 20-k $\Omega$  range.

(3) This electrical specification is ensured by design.

## 7.11 Logic Inputs and Outputs DC Operating Conditions

$V_{IN} = V_{BATT} = 3.6\text{ V}$  (unless otherwise noted). Typical values and limits apply for  $T_J = 25^\circ\text{C}$ ; minimum and maximum limits apply over the entire junction temperature range for operation,  $-40^\circ\text{C}$  to  $+125^\circ\text{C}$ . All voltages are with respect to the potential at the GND pin.

| PARAMETER                                                                             | TEST CONDITIONS                                      | MIN                               | TYP                      | MAX | UNIT          |
|---------------------------------------------------------------------------------------|------------------------------------------------------|-----------------------------------|--------------------------|-----|---------------|
| <b>LOGIC INPUTS (SYS_EN, PWR_EN, SYNC, nRSTI, PWR_ON, nTEST_JIG, SPARE and GPIOs)</b> |                                                      |                                   |                          |     |               |
| $V_{IL}$                                                                              | Low-level input voltage                              |                                   |                          | 0.5 | V             |
| $V_{IH}$                                                                              | High-level input voltage                             | $V_{RTC} - 0.5\text{ V}$          |                          |     | V             |
| $I_{LEAK}$                                                                            | Input leakage current                                | -1                                |                          | 1   | $\mu\text{A}$ |
| <b>LOGIC OUTPUTS (nRSTO, EXT_WAKEUP and GPOs)</b>                                     |                                                      |                                   |                          |     |               |
| $V_{OL}$                                                                              | Output low level                                     | Load = 0.2 mA = $I_{OL}$ maximum  |                          | 0.5 | V             |
| $V_{OH}$                                                                              | Output high level                                    | Load = -0.1 mA = $I_{OL}$ maximum | $V_{RTC} - 0.5\text{ V}$ |     | V             |
| $I_{LEAK}$                                                                            | Output leakage current                               | $V_{ON} = V_{IN}$                 |                          | 5   | $\mu\text{A}$ |
| <b>LOGIC OUTPUT (nBATT_FLT)</b>                                                       |                                                      |                                   |                          |     |               |
| nBATT_FLT threshold voltage                                                           | Programmable via serial interface<br>Default = 2.8 V | 2.4                               | 2.8                      | 3.4 | V             |
| $V_{OL}$                                                                              | Output low level                                     | Load = 0.4 mA = $I_{OL}$ maximum  |                          | 0.5 | V             |
| $V_{OH}$                                                                              | Output high level                                    | Load = -0.2 mA = $I_{OH}$ maximum | $V_{RTC} - 0.5\text{ V}$ |     | V             |
| $I_{LEAK}$                                                                            | Input leakage current                                |                                   |                          | 5   | $\mu\text{A}$ |

## 7.12 I<sup>2</sup>C Compatible Serial Interface Timing Requirements (SDA and SCL)

All voltages are with respect to the potential at the GND pin. See <sup>(1)(2)(3)</sup>

|                      |                                                                                                        | MIN | NOM | MAX | UNIT |
|----------------------|--------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| t <sub>BF</sub>      | Bus-free time between start and stop                                                                   | 1.3 |     |     | μs   |
| t <sub>HOLD</sub>    | Hold Time repeated start condition                                                                     | 0.6 |     |     | μs   |
| t <sub>CLKLP</sub>   | CLK low period                                                                                         | 1.3 |     |     | μs   |
| t <sub>CLKHP</sub>   | CLK high period                                                                                        | 0.6 |     |     | μs   |
| t <sub>SU</sub>      | Setup time repeated start condition                                                                    | 0.6 |     |     | μs   |
| t <sub>DATAHLD</sub> | Data hold time                                                                                         | 0   |     |     | μs   |
| t <sub>CLKSU</sub>   | Data set up time                                                                                       | 100 |     |     | ns   |
| T <sub>SU</sub>      | Setup time for start condition                                                                         | 0.6 |     |     | μs   |
| T <sub>TRANS</sub>   | Maximum pulse width of spikes that must be suppressed by the input filter of both DATA and CLK signals |     | 50  |     | ns   |

(1) All limits specified at room temperature and are production tested, ensured through statistical analysis or ensured by design.

(2) The I<sup>2</sup>C signals behave like open-drain outputs and require an external pullup resistor on the system module in the 2-kΩ to 20-kΩ range.

(3) This electrical specification is ensured by design.

## 7.13 Power-On Timing Delays

See [Initial Cold Start Power-On Sequence](#).

|    | DESCRIPTION                                                    | MIN | TYP | MAX | UNIT |
|----|----------------------------------------------------------------|-----|-----|-----|------|
| t1 | Delay from V <sub>CC_RTC</sub> assertion to nRSTO de-assertion | 50  |     |     | ms   |
| t2 | Delay from nBATT_FLT de-assertion to nRSTI assertion           |     | 100 |     | μs   |
| t3 | Delay from nRST de-assertion to SYS_EN assertion               |     | 10  |     | ms   |
| t4 | Delay from SYS_EN assertion to PWR_EN assertion                |     | 125 |     | ms   |
| t5 | Delay from PWR_EN assertion to nRSTO de-assertion              |     | 125 |     | ms   |

## 7.14 Typical Characteristics

### 7.14.1 LDO Dropout Voltage vs Load Current Collect Data for all LDOs

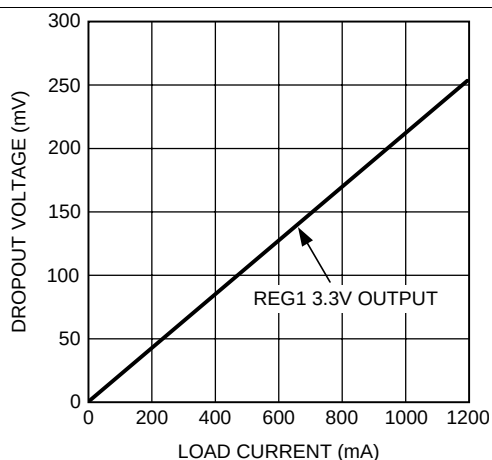


Figure 1. Dropout Voltage vs Load Current

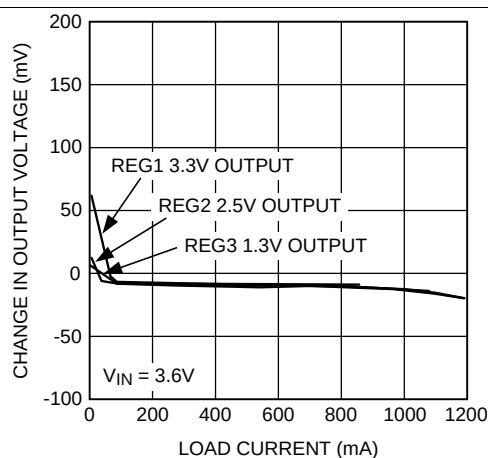


Figure 2. Change In Output Voltage vs Load Current

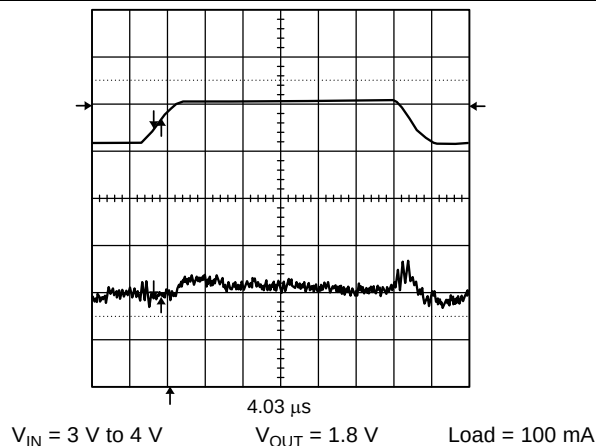


Figure 3. LDO1 Line Regulation

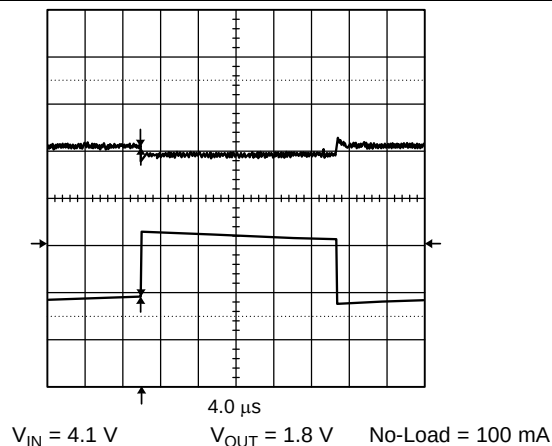


Figure 4. LDO1 Load Transient

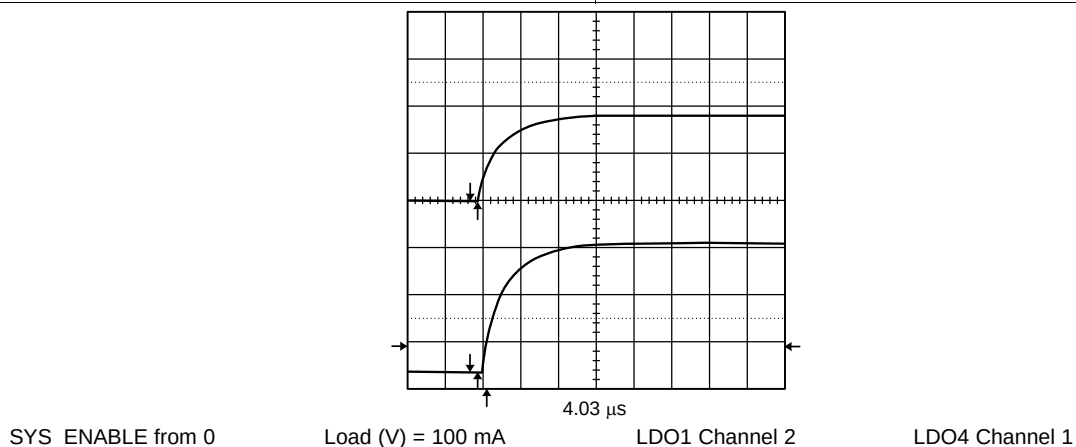


Figure 5. Enable Start-Up Time (LDO1)

### 7.14.2 Buck1 Output Efficiency vs. Load Current Varied From 1 mA to 1.5 A

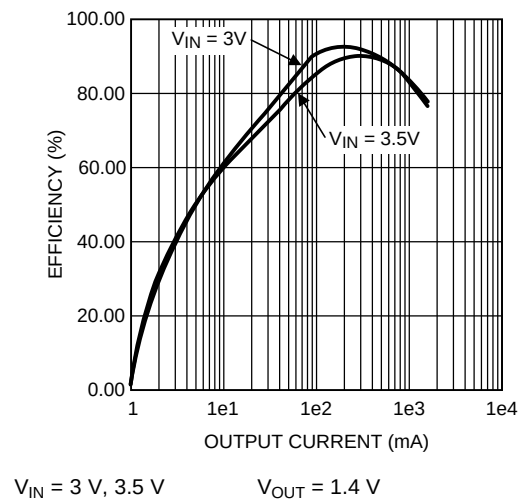


Figure 6. Buck1 Efficiency

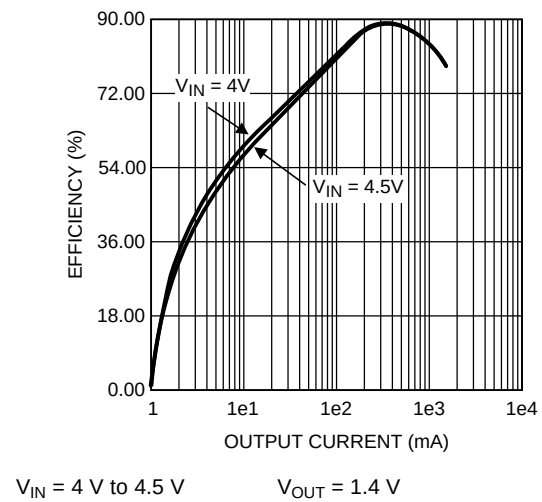


Figure 7. Buck1 Efficiency

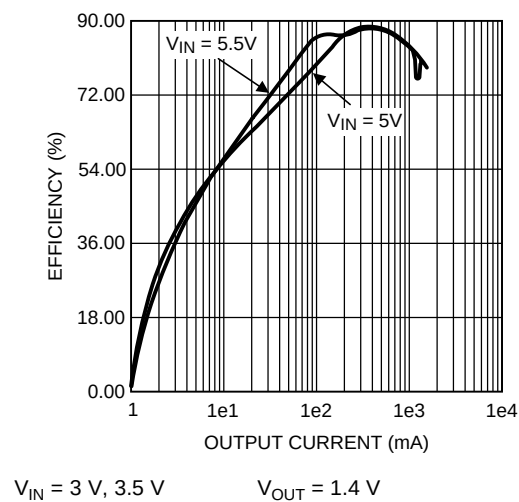


Figure 8. Buck1 Efficiency

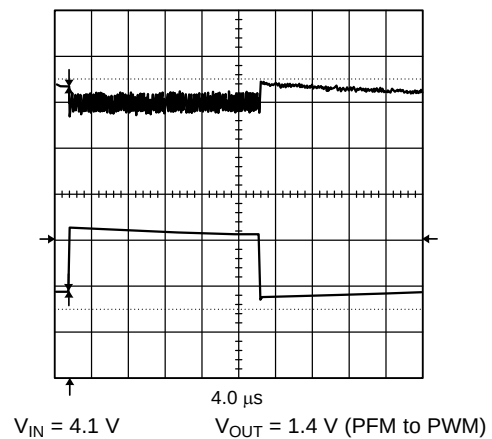


Figure 9. Mode Change Load Transients 20 mA To 560 mA

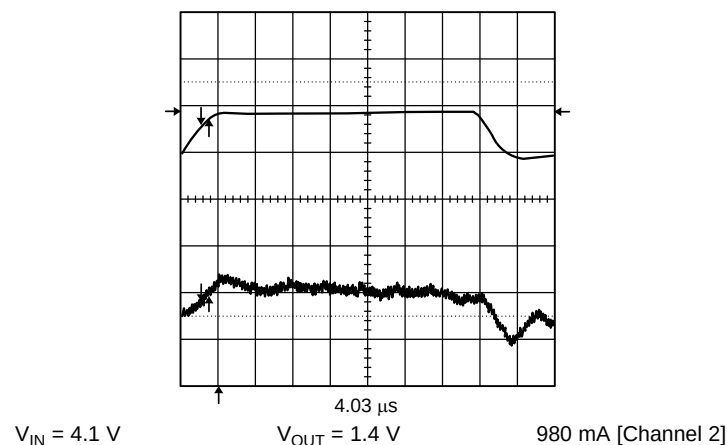


Figure 10. Start-up into PWM Mode

## 8 Detailed Description

### 8.1 Overview

The LP3972 includes three high-efficiency step-down DC-DC switching buck converters. Using a voltage mode architecture with synchronous rectification, the buck converters have the ability to deliver up to 1600 mA depending on the input voltage, output voltage, ambient temperature, and the inductor chosen.

There are three modes of operation depending on the current required: PWM, PFM, and shutdown. The device operates in PWM mode at load currents of approximately 100 mA or higher, having voltage tolerance of  $\pm 3\%$  with 95% efficiency or better. Lighter load currents cause the device to automatically switch into PFM for reduced current consumption. Shutdown mode turns off the device, offering the lowest current consumption ( $I_{Q, \text{SHUTDOWN}} = 0.01 \mu\text{A}$  typical).

Additional features include soft-start, undervoltage protection, current-overload protection, and thermal-shutdown protection.

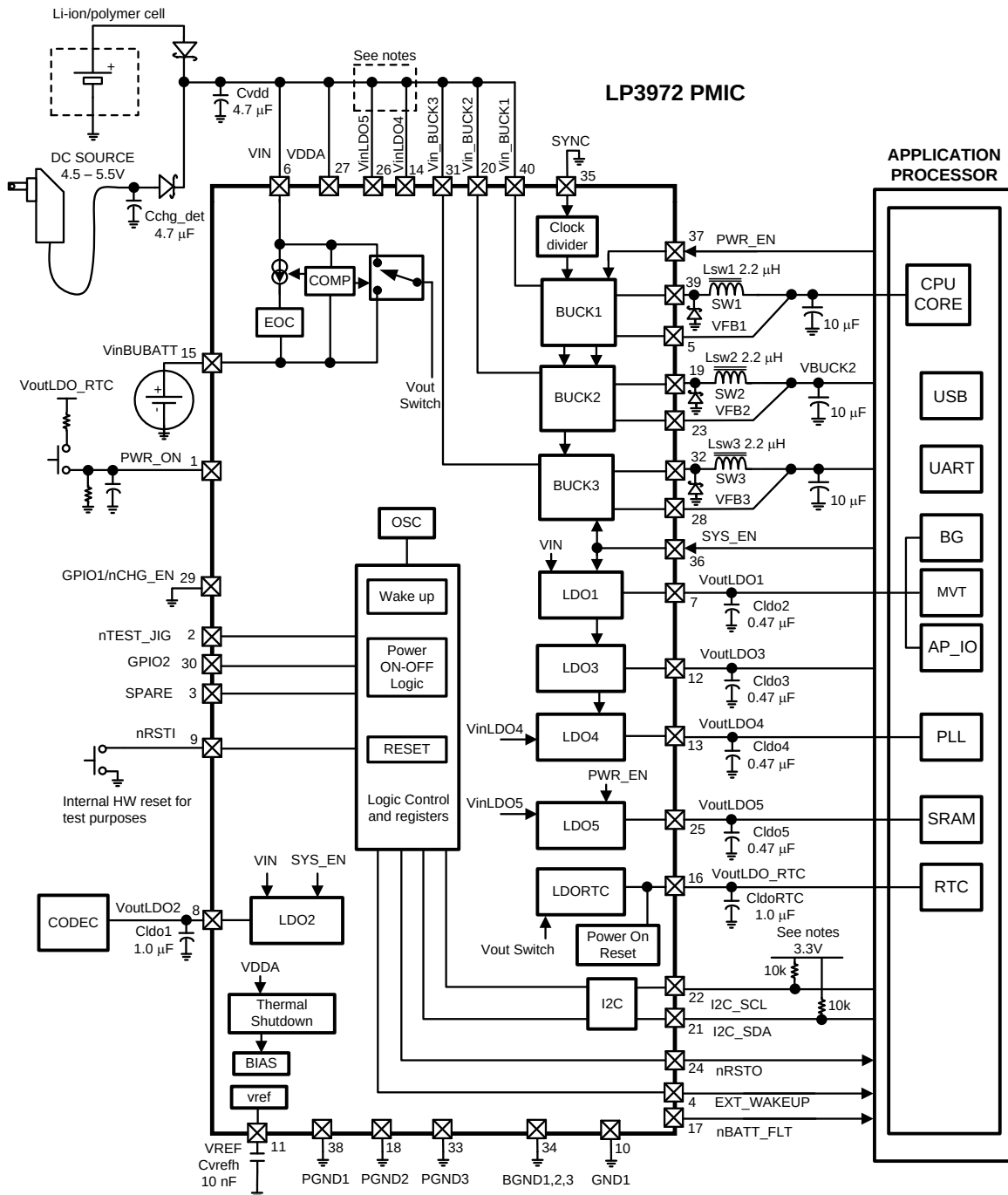
The part uses an internal reference voltage of 0.5 V. TI recommends that the device be kept in shutdown until the input voltage is 2.7 V or higher.

## LP3972

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## 8.2 Functional Block Diagram



- The I<sup>2</sup>C lines are pulled up via a I/O source.
- VINLDOs 4, 5 can either be powered from main battery source or by a buck regulator or V<sub>IN</sub>.

## 8.3 Feature Description

### 8.3.1 Buck Converter Operation

#### 8.3.1.1 Circuit Operation

The buck converter operates as follows: during the first portion of each switching cycle, the control block turns on the internal PFET switch. This allows current to flow from the input through the inductor to the output filter capacitor and load. The inductor limits the current to a ramp with a slope of  $(V_{IN} - V_{OUT})/L$ , by storing energy in a magnetic field.

During the second portion of each cycle, the controller turns the PFET switch off, blocking current flow from the input, and then turns the NFET synchronous rectifier on. The inductor draws current from ground through the NFET to the output filter capacitor and load, which ramps the inductor current down with a slope of  $-V_{OUT}/L$ .

The output filter stores charge when the inductor current is high, and releases it when inductor current is low, smoothing the voltage across the load.

The output voltage is regulated by modulating the PFET switch on time to control the average current sent to the load. The effect is identical to sending a duty-cycle modulated rectangular wave formed by the switch and synchronous rectifier at the SW pin to a low-pass filter formed by the inductor and output filter capacitor. The output voltage is equal to the average voltage at the SW pin.

#### 8.3.1.2 PWM Operation

During pulse width modulation (PWM) operation the converter operates as a voltage mode controller with input voltage feed forward. This allows the converter to achieve good load and line regulation. The DC gain of the power stage is proportional to the input voltage. To eliminate this dependence, feed forward inversely proportional to the input voltage is introduced.

While in PWM mode, the output voltage is regulated by switching at a constant frequency and then modulating the energy per cycle to control power to the load. At the beginning of each clock cycle the PFET switch is turned on, and the inductor current ramps up until the comparator trips and the control logic turns off the switch. The current limit comparator can also turn off the switch in case the current limit of the PFET is exceeded. Then the NFET switch is turned on and the inductor current ramps down. The next cycle is initiated by the clock turning off the NFET and turning on the PFET.

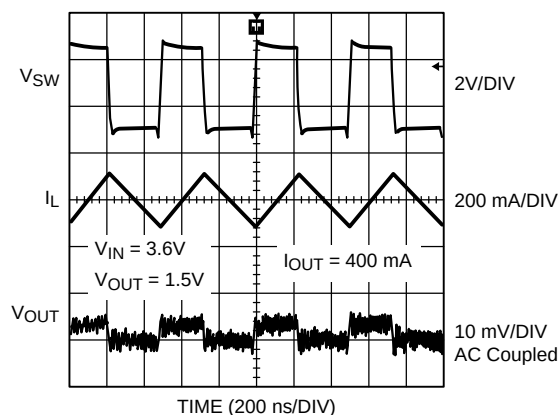


**Figure 11. Typical PWM Operation**

##### 8.3.1.2.1 Internal Synchronous Rectification

While in PWM mode, the converters uses an internal NFET as a synchronous rectifier to reduce rectifier forward voltage drop and associated power loss. Synchronous rectification provides a significant improvement in efficiency whenever the output voltage is relatively low compared to the voltage drop across an ordinary rectifier diode.

## Feature Description (continued)

### 8.3.1.2.2 Current Limiting

A current limit feature allows the converters to protect itself and external components during overload conditions. PWM mode implements current limiting using an internal comparator that trips at 2 A (typical). If the output is shorted to ground the device enters a timed current limit mode where the NFET is turned on for a longer duration until the inductor current falls below a low threshold, ensuring inductor current has more time to decay, thereby preventing runaway.

### 8.3.1.3 PFM Operation

At very light loads, the converter enters pulse frequency modulation (PFM) mode and operates with reduced switching frequency and supply current to maintain high efficiency.

The part automatically transitions into PFM mode when either of two conditions occurs for a duration of 32 or more clock cycles:

1. The inductor current becomes discontinuous.
2. The peak PMOS switch current drops below the  $I_{MODE}$  level (typically  $I_{MODE} < 30 \text{ mA} + V_{IN}/42 \Omega$ ).

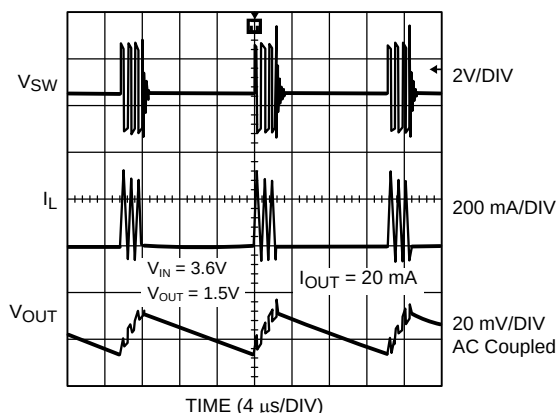


**Figure 12. Typical PFM Operation**

During PFM operation, the converter positions the output voltage slightly higher than the nominal output voltage during PWM operation, allowing additional headroom for voltage drop during a load transient from light to heavy load. The PFM comparators sense the output voltage via the feedback pin and control the switching of the output FETs such that the output voltage ramps between  $< 0.6\%$  and  $< 1.7\%$  above the nominal PWM output voltage. If the output voltage is below the high PFM comparator threshold, the PMOS power switch is turned on. It remains on until the output voltage reaches the *high* PFM threshold or the peak current exceeds the  $I_{PFM}$  level set for PFM mode. The typical peak current in PFM mode is:  $I_{PFM} = 112 \text{ mA} + V_{IN}/27 \Omega$ . Once the PMOS power switch is turned off, the NMOS power switch is turned on until the inductor current ramps to zero. When the NMOS zero-current condition is detected, the NMOS power switch is turned off. If the output voltage is below the high PFM comparator threshold (see [Figure 13](#)), the PMOS switch is again turned on and the cycle is repeated until the output reaches the desired level. Once the output reaches the 'high' PFM threshold, the NMOS switch is turned on briefly to ramp the inductor current to zero and then both output switches are turned off and the part enters an extremely low power mode. Quiescent supply current during this *sleep* mode is  $21 \mu\text{A}$  (typical), which allows the part to achieve high efficiencies under extremely light load conditions. When the output drops below the low PFM threshold, the cycle repeats to restore the output voltage (average voltage in PFM mode) to  $< 1.15\%$  above the nominal PWM output voltage. If the load current increases during PFM mode (see [Figure 13](#)) causing the output voltage to fall below the low2 PFM threshold, the device automatically transitions into fixed-frequency PWM mode. Typically when  $V_{IN} = 3.6 \text{ V}$  the device transitions from PWM-to-PFM mode at 100-mA output current.

## Feature Description (continued)

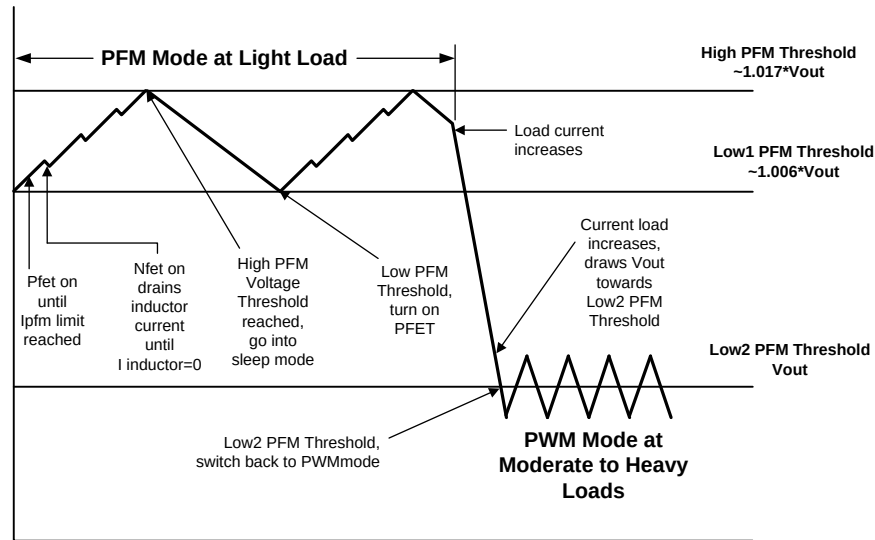


**Figure 13. Operation in PFM Mode and Transfer to PWM Mode**

### 8.3.1.4 Soft Start

The buck converter has a soft-start circuit that limits in-rush current during start-up. During start-up the switch current limit is increased in steps. Soft start is activated only if EN goes from logic low to logic high after  $V_{IN}$  reaches 2.7 V. Soft start is implemented by increasing switch current limit in steps of 213 mA, 425 mA, 850 mA and 1700 mA (typical switch current limit). The start-up time thereby depends on the output capacitor and load current demanded at start-up. Typical start-up time with a 10- $\mu$ F output capacitor and 1000-mA load current is 390  $\mu$ s and with a 1-mA load current, it is 295  $\mu$ s.

### 8.3.1.5 Low Dropout (LDO) Operation

The LP3972 can operate at 100% duty cycle (no switching; PMOS switch completely on) for LDO support of the output voltage. In this way the output voltage is controlled down to the lowest possible input voltage. When the device operates near 100% duty cycle, output voltage ripple is approximately 25 mV. The minimum input voltage needed to support the output voltage is

$$V_{IN, MIN} = I_{LOAD} \times (R_{DS(on), PFET} + R_{INDUCTOR}) + V_{OUT}$$

where

- $I_{LOAD}$  = Load Current
- $R_{DS(on), PFET}$  = drain-to-source resistance of PFET switch in the triode region
- $R_{INDUCTOR}$  = Inductor resistance

(1)

### 8.3.1.6 Spread-Spectrum Feature

Periodic switching in the buck regulator is inherently a noisier function block compared to an LDO. It can be challenging in some critical applications to comply with stringent regulatory standards or simply to minimize interference to sensitive circuits in space limited portable systems. The regulator's switching frequency and harmonics can cause *noise* in the signal spectrum. The magnitude of this noise is measured by its power spectral density. The power spectral density of the switching frequency,  $F_C$ , is one parameter that system designers want to be as low as practical to reduce interference to the environment and subsystems within their products. The LP3972 has a user selectable function on chip, wherein a noise reduction technique known as *spread spectrum* can be employed to ease customer's design and production issues.

## Feature Description (continued)

The principle behind spread spectrum is to modulate the switching frequency slightly and slowly, and spread the signal frequency over a broader bandwidth. Thus, its power spectral density becomes attenuated, and the associated interference electro-magnetic energy is reduced. The clock used to modulate the LP3972 buck regulator can be used as a spread spectrum clock via 2 I<sup>2</sup>C control register (System Control Register 1 (SCR1) 8h'80) bits bk\_ssen, and slomod. With this feature enabled, the intense energy of the clock frequency can be spread across a small band of frequencies in the neighborhood of the center frequency. *This results in a reduction of the peak energy.*

The LP3972 spread-spectrum clock uses a triangular modulation profile with equal rise and fall slopes. The modulation has the following characteristics:

- The center frequency:  $f_C = 2 \text{ MHz}$ , and
- The modulating frequency,  $f_M = 6.8 \text{ kHz}$  or  $12 \text{ kHz}$ .
- Peak frequency deviation:  $\Delta_f = \pm 100 \text{ kHz}$  (or  $\pm 5\%$ )
- Modulation index  $\beta = \Delta_f / f_M = 14.7$  or  $8.3$

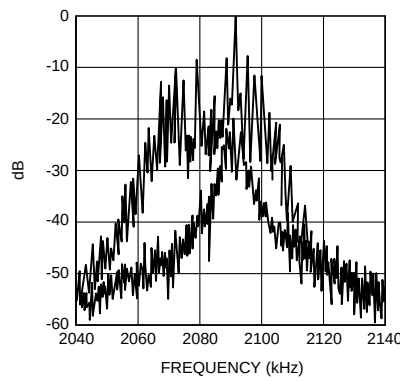


**Figure 14. Switching Energy RBW = 300 Hz**

### 8.3.2 LP3972 Battery Switch Operation

The LP3972 has provisions for two battery connections, the main battery  $V_{BAT}$  and the backup battery.

The function of the battery switch is to connect power to the LDO\_RTC from the appropriate battery, depending on conditions described as follows:

- If only the backup battery is applied, the switch automatically connect sthe LDO\_RTC power to this battery.
- If only the main battery is applied, the switch automatically connects the LDO\_RTC power to this battery
- If both batteries are applied, and the main battery is sufficiently charged ( $V_{BAT} > 3.1 \text{ V}$ ), the switch automatically connects the LDO\_RTC power to the main battery.
- As the main battery is discharged a separate circuit called nBATT\_FLT warns the system. Then if no action is taken to restore the charge on the main battery, and discharging is continued the battery switch disconnects the input of the LDO\_RTC from the main battery and connect to the backup battery.
- The main battery voltage at which the LDO\_RTC is switched over from main to backup battery is  $2.8 \text{ V}$  typically.
- There is a hysteric voltage in this switch operation, thus the LDO\_RTC is not reconnected to main battery until main battery voltage is greater than  $3.1 \text{ V}$  typically.
- The system designer may wish to disable the battery switch when only a main battery is used. This is accomplished by setting the *no backup battery bit* in the control register 8h'0B bit 7 NBUB. With this bit set to 1, the switching does not occur; that is, the LDO\_RTC remains connected to the main battery even as it is discharged below the  $2.9\text{-V}$  threshold. The backup battery input must also be connected to main battery.

## 8.4 Device Functional Modes

### 8.4.1 Start-Up Mode

Start-up mode is entered once the battery backup supply is connected to LP3972. The RTC LDO is then turned on to power the VCC\_BATT pin of the application processor. Start-up state exits once nRSTO de-asserts (after a minimum of 50 ms) and when nBATT\_FLT de-asserts once system power is available.

### 8.4.2 Shutdown Mode

During shutdown the PFET switch, reference, control and bias circuitry of the converters are turned off. The NFET switch opens in shutdown to discharge the output. When the converter is enabled, EN, soft start is activated. It is recommended to disable the converter during the system power up and undervoltage conditions when the supply is less than 2.7V.

### 8.4.3 Standby Mode

Once NRSTO and nBATT\_FLT are de-asserted the LP3972 waits for SYS\_EN signal in standby mode. All high-voltage power domains are still disabled in this state.

### 8.4.4 Active Mode

Once SYS\_EN goes high the device begins turning on the high-voltage power supplies. Once PWR\_EN goes high the LP3972 enables the low-voltage power supplies. The Apps processor must monitor the “Power OK” status bits before beginning execution of code to make sure all supplies have been properly enabled.

## 8.5 Programming

### 8.5.1 LP3972 Reset Sequence

#### 8.5.1.1 LP3972 Controls

##### 8.5.1.1.1 Digital Interface Control Signals

| SIGNAL          | DEFINITION                                                  | ACTIVE STATE | SIGNAL DIRECTION     |
|-----------------|-------------------------------------------------------------|--------------|----------------------|
| SYS_EN          | High Voltage Power Enable                                   | High         | Input                |
| PWR_EN          | Low Voltage Power Enable                                    | High         | Input                |
| SCL             | Serial Bus Clock Line                                       | Clock        | Input                |
| SDA             | Serial Bus Data Line                                        |              | Bidirectional        |
| nRSTI           | Forces an unconditional hardware reset                      | Low          | Input                |
| nRSTO           | Forces an unconditional hardware reset                      | Low          | Output               |
| nBATT_FLT       | Main Battery removed or discharged indicator                | Low          | Output               |
| PWR_ON          | Wake-up Input to CPU                                        | High         | Input                |
| nTEST_JIG       | Wake-up Input to CPU                                        | Low          | Input                |
| SPARE           | Wake-up Input to CPU                                        | High/Low     | Input                |
| EXT_WAKEUP      | Wake-up Output for application processor                    | High         | Output               |
| GPIO1 / nCHG_EN | General Purpose I/O /External backup Battery Charger enable | —            | Bidirectional /Input |
| GPIO2           | General Purpose I/O                                         | —            | Bidirectional        |

### 8.5.1.1.2 Power Domain Enables

**Table 3. Hardware and Software Enable Options for Each Supply**

| PMU OUTPUT                    | HW ENABLE | SW ENABLE |
|-------------------------------|-----------|-----------|
| LDO_RTC                       | —         | —         |
| LDO1 (V <sub>CC_MVT</sub> )   | SYS_EN    | LDO1_EN   |
| LDO2                          | SYS_EN    | LDO2_EN   |
| LDO3                          | SYS_EN    | LDO3_EN   |
| LDO4                          | SYS_EN    | LDO4_EN   |
| LDO5 (V <sub>CC_SRAM</sub> )  | PWR_EN    | S_EN      |
| Buck1 (V <sub>CC_APPS</sub> ) | PWR_EN    | A_EN      |
| BUCK2                         | SYS_EN    | B2_EN     |
| BUCK3                         | SYS_EN    | B3_EN     |

### 8.5.1.1.3 Power Domains Sequencing (Delay)

By default SYS\_EN must be on to have PWR\_EN enable but this feature can be switched off by register bit BP\_SYS.

By default always enables SYS\_EN LDO1 and, after a typical 1-ms delay, others. Also when SYS\_EN is set off the LDO1 goes off last. This function can be switched off or delay can be changed by DELAY bits via serial interface as seen in [Table 4](#).

8h'80 Bit 5:4

**Table 4. Programmable Supply Delay Options**

| DELAY (bits) | DELAY (ms) |
|--------------|------------|
| 00           | 0          |
| 01           | 0.5        |
| 10           | 1          |
| 11           | 1.5        |

### 8.5.1.1.4 Power Supply Enable

SYS\_EN and PWR\_EN can be changed by programmable register bits.

### 8.5.1.1.5 Wake-up Functionality (PWR\_ON, NTEST\_JIG, SPARE and EXT\_WAKEUP)

Three input pins can be used to assert wake-up output for 10 ms for application processor notification to wake up. SPARE Input can be programmed through I<sup>2</sup>C-compatible interface to be active low or high (SPARE bit, Default is active low 1). A reason for a wake-up event can be read through I<sup>2</sup>C-compatible interface also. Additionally, wake-up inputs have 30 ms de-bounce filtering, and PWR\_ON distinguishes between short and long (~1 s) pulses (push-button input). The LP3972 also has an internal thermal shutdown early warning that generates a wake-up to the system also. This is generated usually at 125°C.

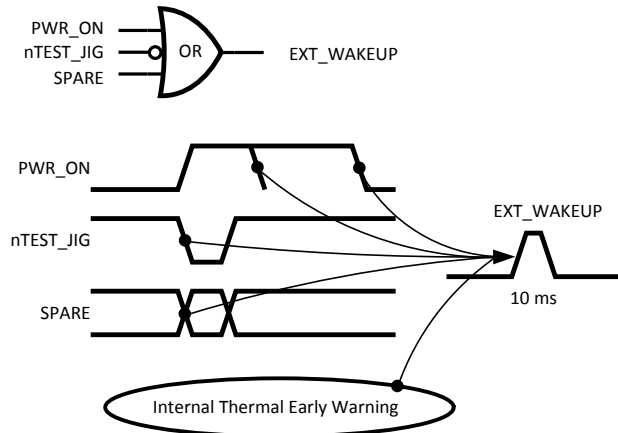


**Figure 15. Wake-Up Functionality**

**Table 5. Wake-Up Functions**

| WAKE-UP REGISTER BITS | REASON FOR WAKE-UP |
|-----------------------|--------------------|
| WUP0                  | SPARE              |
| WUP1                  | TEST_JIG           |
| WUP2                  | PWR_ON short pulse |
| WUP3                  | PWR_ON long pulse  |
| TSD_EW                | TSD Early Warning  |

#### 8.5.1.1.6 Internal Thermal Shutdown Procedure

Thermal shutdown is build to generate early warning (typically 125°C) which triggers the EXT\_WAKEUP for the processor acknowledge. When a thermal shutdown triggers (typical 160°C) the PMU resets the system until the device cools down.

#### 8.5.1.1.7 Battery Switch and Backup Battery Charger

When backup battery is connected but the main battery has been removed or its supply voltage too low, the LP3972 uses the backup battery for generating LDO\_RTC voltage. When Main Battery is available the battery FET switches over to the main battery for LDO\_RTC voltage. When the main battery voltage is too low or removed nBATT\_FLT is asserted. If no backup battery exists, the battery switch to backup can be switched off by nBU\_BAT\_EN bit. User can set the battery fault determination voltage and battery charger current via I<sup>2</sup>C-compatible interface. Enabling of backup battery charger can be done via serial interface (nBAT\_CHG\_EN) or external charger enable pin (nCHG\_EN). The GPIO1/nCHG\_EN pin is set as an external charger enable input by default.

#### 8.5.1.1.8 General Purpose I/O Functionality (GPIO1 And GPIO2)

The LP3972 has 2 general purpose I/Os for system control. I<sup>2</sup>C-compatible interface is used for setting any of the pins to input, output or hi-Z mode. Inputs value can be read via serial interface (GPIO1,2 bits). The GPIO1/nCHG\_EN pin functionality needs to be set to GPIO by serial interface register bit nEXTCHGEN (GPIO/CHG).

**Table 6. GPIO1 Configuration Options**

| CONTROLS |         |               |       | PORT FUNCTION | reg    | batmonchg   |
|----------|---------|---------------|-------|---------------|--------|-------------|
| GPIO<1>  | GPIO<1> | Nextchgen_sel | bucen | GPIO1         | Gpin 1 | Function    |
| X        | X       | 1             | 0     | Input = 0     | 0      | Enabled     |
| X        | X       | 1             | 0     | Input = 1     | 0      | Not enabled |
| 1        | 0       | 1             | X     | X             | 0      |             |
| X        | X       | X             | 1     | X             |        | Enabled     |
| 0        | 0       | 0             | X     | HiZ           |        |             |
| 1        | 0       | 0             | X     | Input (dig)-> | Input  |             |
| 0        | 1       | 0             | X     | Output = 0    | 0      |             |
| 1        | 1       | 0             | X     | Output = 1    | 0      |             |

**Table 7. GPIO2 Configuration Options**

| GPIO<1> | GPIO<1> | GPIO_tstioib | GPIO2         | gpin2 |
|---------|---------|--------------|---------------|-------|
| 0       | 0       | 1            | HiZ           | 0     |
| 1       | 0       | 1            | Input (dig)-> | input |
| 0       | 1       | 1            | Output = 0    | 0     |
| 1       | 1       | 1            | Output = 1    | 0     |

The LP3972 has provision for two battery connections, the main battery  $V_{BAT}$  and backup battery (see [Figure 27](#)).

The function of the battery switch is to connect power to the LDO\_RTC from the appropriate battery, depending on conditions described as follows:

- If only the backup battery is applied, the switch automatically connects the LDO\_RTC power to this battery.
- If only the main battery is applied, the switch automatically connects the LDO\_RTC power to this battery.
- If both batteries are applied, and the main battery is sufficiently charged ( $V_{BAT} > 3.1$  V), the switch automatically connects the RTC LDO power to the main battery.
- As the main battery is discharged by use, the user is warned by a separate circuit called nBATT\_FLT. Then if no action is taken to restore the charge on the main battery, and discharging is continued the battery switch protects the LDO\_RTC by disconnecting from the main battery and connecting to the backup battery.
  - The main battery voltage at which the LDO\_RTC is switched from main to backup battery is 2.9 V typically.
  - There is a hysteresis voltage in this switch operation so, the LDO\_RTC is not reconnected to main battery until main battery voltage is greater than 3.1 V typically.
- Additionally, the user may wish to disable the battery switch, such as, in the case when only a main battery is used. This is accomplished by setting the *no backup battery bit* in the control register 8h'89 bit 7 NBUB. With this bit set to 1, the switching does not occur; that is, the LDO\_RTC remains connected to the main battery even as it is discharged below the 2.9-V threshold.

#### 8.5.1.1.9 Regulated Voltages OK

All the power domains have own register bit (X\_OK) that processor can read via serial interface to be sure that enabled powers are OK (regulating). Note that these read only bits are only valid when regulators are settled (avoid reading these bits during voltage change or power up).

#### 8.5.1.1.10 Thermal Management

There is a mode wherein all 6 comparators (flags) can be turned on via the *enallflags* control register bit. This mode allows the user to interrogate the device or system temperature under the set operating conditions. Thus, the rate of temperature change can also be estimated. The system may then negotiate for speed and power trade off, or deploy cooling maneuvers to optimize system performance. The *enallflags* bit needs enabled only when the bct<2:0> bits are read to conserve power.

**NOTE**

The thermal management flags have been verified functional. Presently these registers are accessible by factory only. If there is a demand for this function, the relevant register controls may be shifted into the user programmable bank; the temperature range and resolution of these flags, might also be refined or redefined.

**8.5.1.1.11 Thermal Warning**

Two of six low-power comparators, each consuming less than 1  $\mu$ A, are always enabled to operate the  $T = 125^{\circ}\text{C}$  warning flag with hysteresis. This allows continuous monitoring of a thermal-warning flag feature with very low power consumption.

**8.5.1.1.12 LP3972 Thermal Flags Functional Diagram, Data from Initial Silicon**

Figure 16 shows extra features from the thermal shutdown circuit:

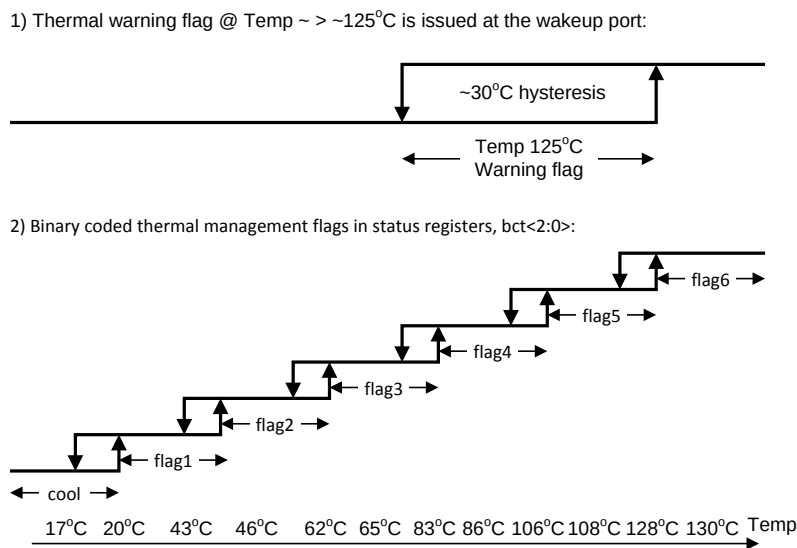


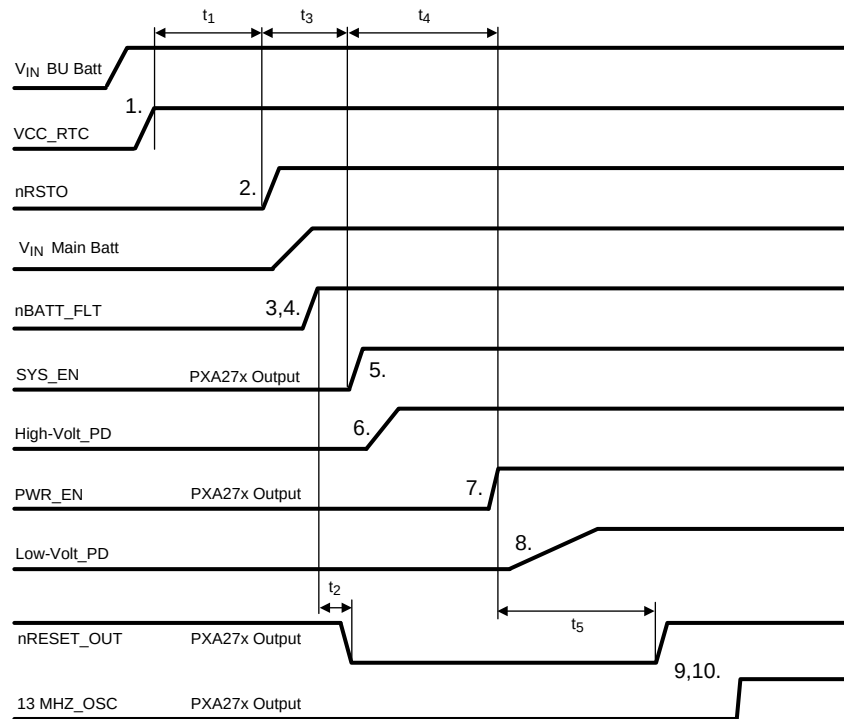
**Figure 16. Thermal Shutdown Circuit Features**

**8.5.1.2 Initial Cold Start Power-On Sequence**

1. The backup battery is connected to the PMU, power is applied to the backup battery pin, the LDO\_RTC turns on and supplies a stable output voltage to the  $V_{CC\_BATT}$  pin of the Applications processor (initiating the power-on reset event) with nRSTO asserted from the LP3972 to the processor.
2. nRSTO de-asserts after a minimum of 50 ms.
3. The applications processor waits for the de-assertion of nBATT\_FLT to indicate system power ( $V_{IN}$ ) is available.
4. After system power ( $V_{IN}$ ) is applied, the LP3972 de-asserts nBATT\_FLT. Note that BOTH nRSTO and nBATT\_FLT need to be de-asserted before SYS\_EN is enabled. The sequence of the two signals is independent of each other.
5. The Applications processor asserts SYS\_EN, the LP3972 enables the system high-voltage power supplies. The applications processor starts its countdown timer set to 125 ms.
6. The LP3972 enables the high-voltage power supplies.
  - LDO1 power for  $V_{CC\_MVT}$  (power for internal logic and I/O Blocks), BG (bandgap reference voltage), OSC13M (13-MHz oscillator voltage) and PLL enabled first, followed by others if delay is on.
7. Countdown timer expires; the applications processor asserts PWR\_EN to enable the low-voltage power supplies. The processor starts the countdown timer set to 125 ms period.
8. The applications processor asserts PWR\_EN (ext. pin or  $I^2C$ ), the LP3972 enables the low-voltage regulators.

9. Countdown timer expires; if enabled power domains are OK ( $I^2C$  read) the power-up sequence continues by enabling the 13-MHz oscillator of the processor and PLLs.
10. The applications processor begins the execution of code.

See [Power-On Timing Delays](#) for more information.



\* Note that BOTH nRSTO and nBATT\_FLT need to be de-asserted before SYS\_EN is enabled. The sequence of the two signals is independent of each other and can occur in either order.

**Figure 17. Cold Start Power-On Efficiency**

### 8.5.1.3 Hardware Reset Sequence

Hardware reset initiates when the nRSTI signal is asserted (low). Upon assertion of nRST the processor enters hardware reset state. The LP3972 holds the nRST low long enough (50 ms typica) to allow the processor time to initiate the reset state.

### 8.5.1.4 Reset Sequence

1. nRSTI is asserted.
2. nRSTO is asserted and de-asserts after a minimum of 50 ms.
3. The Applications processor waits for the de-assertion of nBATT\_FLT to indicate system power ( $V_{IN}$ ) is available.
4. After system power ( $V_{IN}$ ) is turned on, the LP3972 de-asserts nBATT\_FLT.
5. The applications processor asserts SYS\_EN, the LP3972 enables the system high-voltage power supplies. The applications processor starts its countdown timer set to 125 ms.
6. The LP3972 enables the high-voltage power supplies.
7. Countdown timer expires; the applications processor asserts PWR\_EN to enable the low-voltage power supplies. The processor starts the countdown timer set to 125 ms.
8. The applications processor asserts PWR\_EN, the LP3972 enables the low-voltage regulators.
9. Countdown timer expires; if enabled power domains are OK ( $I^2C$  read) the power-up sequence continues by enabling the 13-MHz oscillator of the processor and PLLs.
10. The applications processor begins the execution of code.

## 8.5.2 I<sup>2</sup>C Compatible Interface

### 8.5.2.1 I<sup>2</sup>C Data Validity

The data on SDA line must be stable during the HIGH period of the clock signal (SCL). In other words, state of the data line can only be changed when CLK is LOW.

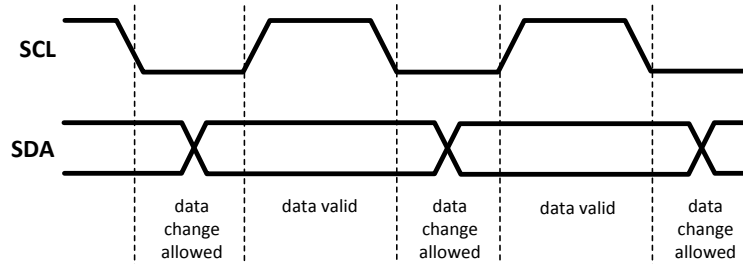


**Figure 18. Data Validity**

### 8.5.2.2 I<sup>2</sup>C Start And Stop Conditions

START and STOP bits classify the beginning and the end of the I<sup>2</sup>C session. START condition is defined as SDA signal transitioning from HIGH to LOW while SCL line is HIGH. STOP condition is defined as the SDA transitioning from LOW to HIGH while SCL is HIGH. The I<sup>2</sup>C master always generates START and STOP bits. The I<sup>2</sup>C bus is considered to be busy after START condition and free after STOP condition. During data transmission, I<sup>2</sup>C master can generate repeated START conditions. First START and repeated START conditions are equivalent, function-wise.

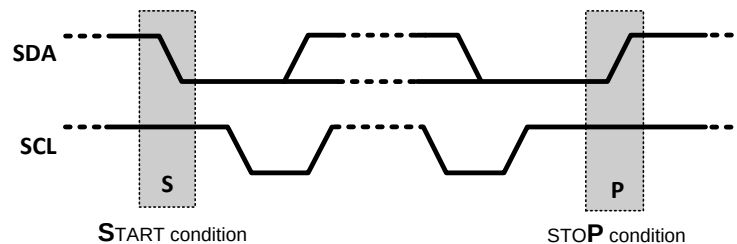


**Figure 19. Stop and Start Conditions**

### 8.5.2.3 Transferring Data

Every byte put on the SDA line must be eight bits long, with the most significant bit (MSB) being transferred first. The number of bytes that can be transmitted per transfer is unrestricted. Each byte of data has to be followed by an acknowledge bit. The acknowledge related clock pulse is generated by the master. The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the SDA line during the 9th clock pulse, signifying an acknowledge. A receiver which has been addressed must generate an acknowledge after each byte has been received.

After the START condition, a chip address is sent by the I<sup>2</sup>C master. This address is seven bits long followed by an eighth bit which is a data direction bit (R/W). The LP3972 address is 34h. For the eighth bit, a 0 indicates a WRITE and a 1 indicates a READ. The second byte selects the register to which the data will be written. The third byte contains data to write to the selected register.

### 8.5.2.4 I<sup>2</sup>C Chip Address - 7h'34

**Table 8. I<sup>2</sup>C Slave Address**

| MSB          |              |              |              |              |              |              |             |
|--------------|--------------|--------------|--------------|--------------|--------------|--------------|-------------|
| ADR6<br>Bit7 | ADR5<br>Bit6 | ADR4<br>Bit5 | ADR3<br>Bit4 | ADR2<br>Bit3 | ADR1<br>Bit2 | ADR0<br>Bit1 | R/W<br>Bit0 |
| 0            | 1            | 1            | 0            | 1            | 0            | 0            | R/W         |

### 8.5.2.4.1 Write Cycle

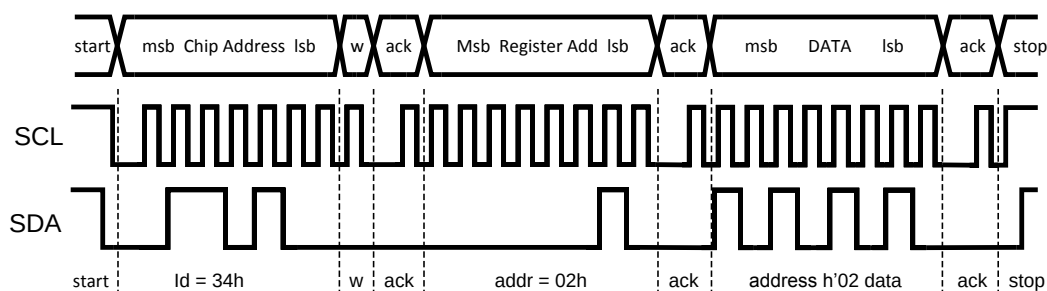
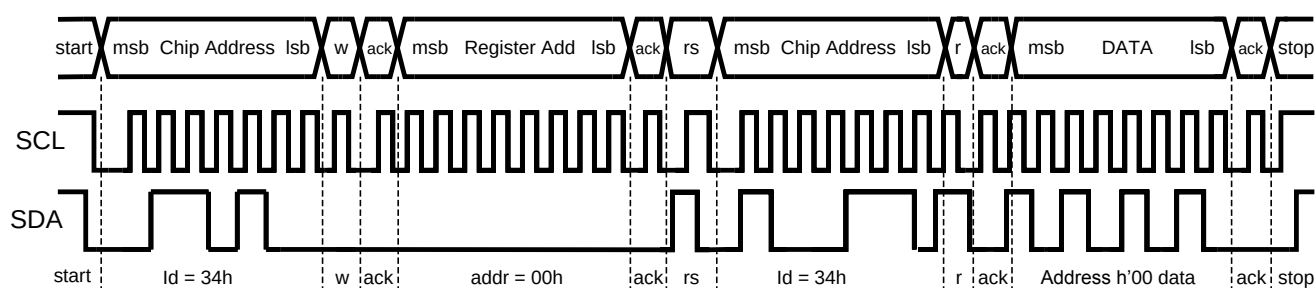


**Figure 20. Write Cycle**

### 8.5.2.4.2 Read Cycle

When a READ function is to be accomplished, a WRITE function must precede the READ function as follows.



w = write (SDA = "0")

r = read (SDA = "1")

ack = acknowledge (SDA pulled down by either master or slave)

rs = repeated start

id = 34h (Chip Address)

**Figure 21. Read Cycle**

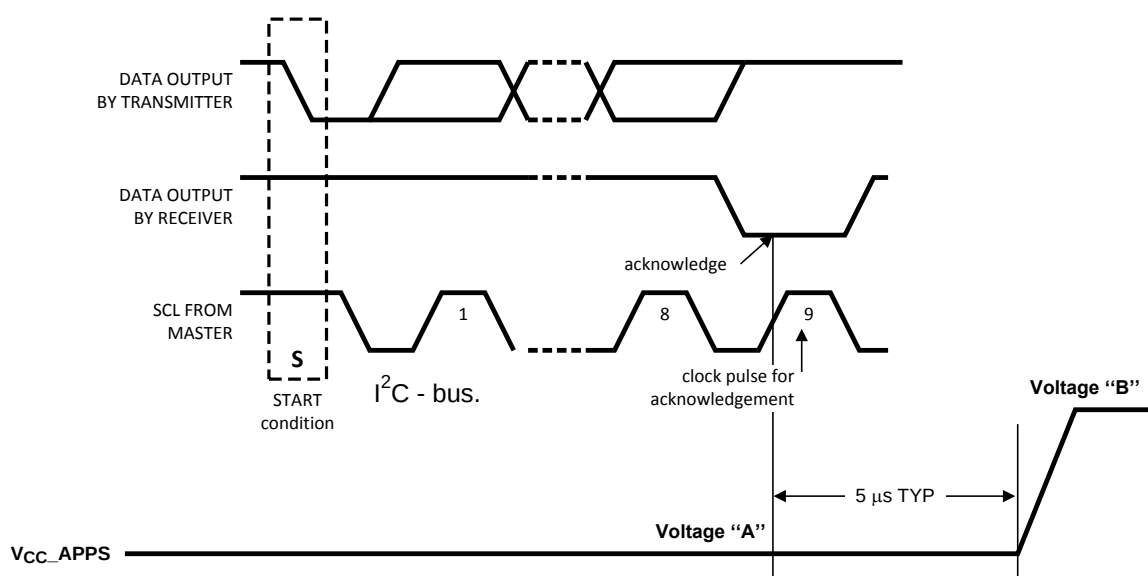


**Figure 22. I²C DVM Timing For V<sub>CC\_APPS</sub> (Buck1)**

### 8.5.2.5 Multi-Byte I<sup>2</sup>C Command Sequence

To correctly function with the Monahan's Power Management I<sup>2</sup>C the I<sup>2</sup>C serial interface of the device supports random register multi-byte command sequencing: During a multi-byte write the Master sends the start command followed by the device address, which is sent only once, followed by the 8-bit register address, then 8 bits of data. The I<sup>2</sup>C slave must then accept the next random register address followed by 8 bits of data and continue this process until the master sends a valid stop condition.

A typical multi-byte random register transfer is outlined in the following:

|                |                                                                                                                                                                                                                    |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Device Address | Register A Address, Ach,<br>Register A Data, Ach<br>Register M Address, Ach,<br>Register M Data, Ach<br>Register X Address, Ach,<br>Register X Data, Ach<br>Register Z Address, Ach,<br>Register Z Data, Ach, Stop |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|

#### NOTE

The PMIC is not required to see the I<sup>2</sup>C device address for each transaction. A, M, X, and Z are Random numbers.

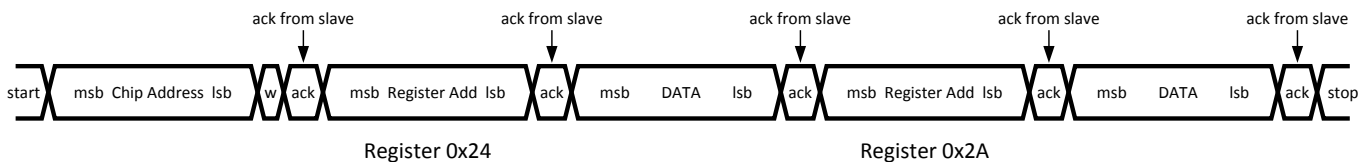


**Figure 23. Multi-Byte I<sup>2</sup>C Command**

### 8.5.2.6 Incremental Register I<sup>2</sup>C Command Sequence

The LP3972 supports address increment (burst mode). When there is a defined register address n data bytes can be sent, and the register address is incremented after each data byte has been sent. Address incrimination may be required for non XScale applications. User can define whether multi-byte (default) to random address or address incrimination will be used.

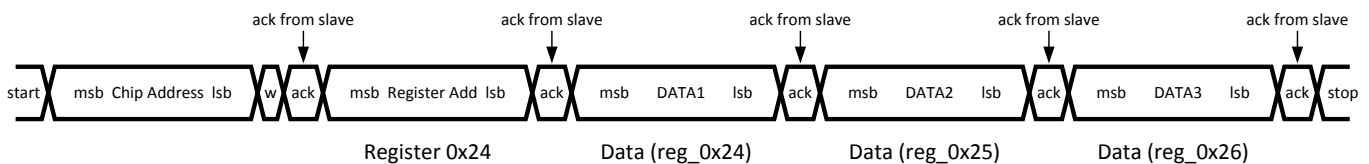


**Figure 24. Incremental Register I<sup>2</sup>C Command**

## 8.6 Register Maps

**Table 9. LP3972 Control Register**

| REGISTER ADDRESS | REGISTER NAME     | READ/WRITE | REGISTER DESCRIPTION                      |
|------------------|-------------------|------------|-------------------------------------------|
| 8h'07            | SCR               | R/W        | System Control Register                   |
| 8h'10            | OVER1             | R/W        | Output Voltage Enable Register 1          |
| 8h'11            | OVS1R1            | R          | Output Voltage Status Register 1          |
| 8h'12            | OVER2             | R/W        | Output Voltage Enable Register 2          |
| 8h'13            | OVS2R2            | R          | Output Voltage Status Register 2          |
| 8h'20            | V <sub>CC</sub> 1 | R/W        | Voltage Change Control Register 1         |
| 8h'23            | ADTV1             | R/W        | Buck1 Target Voltage 1 Register           |
| 8h'24            | ADTV2             | R/W        | Buck1 DVM Target Voltage 2 Register       |
| 8h'25            | AVRC              | R/W        | V <sub>CC_APPS</sub> Voltage Ramp Control |
| 8h'26            | CDTC1             | W          | Dummy Register                            |
| 8h'27            | CDTC2             | W          | Dummy Register                            |
| 8h'29            | SDTV1             | R/W        | LDO5 Target Voltage 1                     |
| 8h'2A            | SDTV2             | R/W        | LDO5 Target Voltage 2                     |
| 8h'32            | MDTV1             | R/W        | LDO1 Target Voltage 1 Register            |
| 8h'33            | MDTV2             | R/W        | LDO1 Voltage 2 Register                   |
| 8h'39            | L2VCR             | R/W        | LDO2 Voltage Control Registers            |
| 8h'3A            | L34VCR            | R/W        | LDO3 & LDO4 Voltage Control Registers     |
| 8h'80            | SCR1              | R/W        | System Control Register 1                 |
| 8h'81            | SCR2              | R/W        | System Control Register 2                 |
| 8h'82            | OEN3              | R/W        | Output Voltage Enable Register 3          |
| 8h'83            | OSR3              | R/W        | Output Voltage Status Register 3          |
| 8h'84            | LOER4             | R/W        | Output Voltage Enable Register 3          |
| 8h'85            | B2TV              | R/W        | V <sub>CC_Buck2</sub> Target Voltage      |
| 8h'86            | B3TV              | R/W        | V <sub>CC_Buck3</sub> Target Voltage      |
| 8h'87            | B32RC             | R/W        | Buck 3:2 Voltage Ramp Control             |
| 8h'88            | ISRA              | R          | Interrupt Status Register A               |
| 8h'89            | BCCR              | R/W        | Backup Battery Charger Control Register   |
| 8h'8E            | II1RR             | R          | Internal 1 Revision Register              |
| 8h'8F            | II2RR             | R          | Internal 2 Revision Register              |

### 8.6.1 Serial Interface Register Selection Codes

#### 8.6.1.1 System Control Status Register

Register is an 8-bit register which specifies the control bits for the PMIC clocks. This register works in conjunction with the SYNC pin where an external clock PLL buffer operating at 13 MHz is synchronized with the oscillators of the buck converters.

### 8.6.1.1.1 System Control Register (SCR) 8h'07

| Bit         | 7        | 6 | 5 | 4 | 3 | 2 | 1 | 0       |
|-------------|----------|---|---|---|---|---|---|---------|
| Designation | Reserved |   |   |   |   |   |   | CLK_SCL |
| Reset Value | 0        | 0 | 0 | 0 | 0 | 0 | 0 | 0       |

### 8.6.1.1.2 System Control Register (SCR) 8h'07 Definitions

| Bit | Access | Name    | Description                                                                                                                            |
|-----|--------|---------|----------------------------------------------------------------------------------------------------------------------------------------|
| 7-1 | —      | —       | Reserved                                                                                                                               |
| 0   | R/W    | CLK_SCL | External Clock Select<br>0 = Internal oscillator clock for buck converters<br>1 = External 13-MHz oscillator clock for buck converters |

### 8.6.1.2 Output Voltage Enable Register 1

This register enables or disables the low voltage supplies LDO1 and Buck1. See details below.

#### 8.6.1.2.1 Output Voltage Enable Register 1 (OVER1) 8h'10

| Bit         | 7        | 6 | 5 | 4 | 3 | 2    | 1        | 0    |
|-------------|----------|---|---|---|---|------|----------|------|
| Designation | Reserved |   |   |   |   | S_EN | Reserved | A_EN |
| Reset Value | 0        | 0 | 0 | 0 | 0 | 1    | 0        | 1    |

#### 8.6.1.2.2 Output Voltage Enable Register 1 (OVER1) 8h'10 Definitions

| Bit | Access | Name | Description                                                                                                                                                             |
|-----|--------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7-3 | —      | —    | Reserved                                                                                                                                                                |
| 2   | R/W    | S_EN | V <sub>CC_SRAM</sub> (LDO5) Supply Output Enabled<br>0 = V <sub>CC_SRAM</sub> (LDO5) Supply Output Disabled<br>1 = V <sub>CC_SRAM</sub> (LDO5) Supply Output Enabled    |
| 1   | —      | —    | Reserved                                                                                                                                                                |
| 0   | R/W    | A_EN | V <sub>CC_APPS</sub> (Buck1) Supply Output Enabled<br>0 = V <sub>CC_APPS</sub> (Buck1) Supply Output Disabled<br>1 = V <sub>CC_APPS</sub> (Buck1) Supply Output Enabled |

### 8.6.1.3 Output Voltage Status Register

This 8-bit register is used to indicate the status of the low-voltage supplies. By polling each of the specify supplies is within its specified operating range.

#### 8.6.1.3.1 Output Voltage Status Register 1 (OVS1) 8h'11

| Bit         | 7     | 6        | 5 | 4 | 3 | 2    | 1        | 0    |
|-------------|-------|----------|---|---|---|------|----------|------|
| Designation | LP_OK | Reserved |   |   |   | S_OK | Reserved | A_OK |
| Reset Value | 0     | 0        | 0 | 0 | 0 | 0    | 0        | 0    |

#### 8.6.1.3.2 Output Voltage Status Register 1 (OVS1) 8h'11 Definitions

| Bit | Access | Name  | Description                                                                                                                                                                                                                                                    |
|-----|--------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | R      | LP_OK | Low Voltage Supply Output Voltage Status<br>0 - V <sub>CC_APPS</sub> (Buck1) and V <sub>CC_SRAM</sub> (LDO5) output voltage < 90% of selected value<br>1 - V <sub>CC_APPS</sub> (Buck1) and V <sub>CC_SRAM</sub> (LDO5) output voltage > 90% of selected value |
| 6:3 | —      | —     | Reserved                                                                                                                                                                                                                                                       |
| 2   | R      | S_OK  | V <sub>CC_SRAM</sub> Supply Output Voltage Status<br>0 - V <sub>CC_SRAM</sub> (LDO5) output voltage < 90% of selected value<br>1 - V <sub>CC_SRAM</sub> (LDO5) output voltage > 90% of selected value                                                          |

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| Bit | Access | Name | Description                                                                                                                                                                                             |
|-----|--------|------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1   | —      | —    | Reserved                                                                                                                                                                                                |
| 0   | R      | A_OK | V <sub>CC_APPS</sub> Supply output Voltage Status<br>0 - V <sub>CC_APPS</sub> (Buck1) output voltage < 90% of selected value<br>1 - V <sub>CC_APPS</sub> (Buck1) output voltage > 90% of selected value |

**8.6.1.4 Output Voltage Enable Register 2**

This 8 bit output register enables and disables the output voltages on the LDOs 2,3,4 supplies.

**8.6.1.4.1 Output Voltage Enable Register 2 (OVER2) 8h'12**

| Bit         | 7        | 6 | 5 | 4 <sup>(1)</sup> | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1        | 0 |
|-------------|----------|---|---|------------------|------------------|------------------|----------|---|
| Designation | Reserved |   |   | LDO4_EN          | LDO3_EN          | LDO2_EN          | Reserved |   |
| Reset Value | 0        | 0 | 0 | 0                | 0                | 0                | 0        | 0 |

(1) One-time factory programmable EPROM registers for default values

**8.6.1.4.2 Output Voltage Enable Register 2 (OVER2) 8h'12 Definitions**

| BIT | ACCESS | NAME    | DESCRIPTION                                                                                              |
|-----|--------|---------|----------------------------------------------------------------------------------------------------------|
| 7   | —      | —       | Reserved                                                                                                 |
| 6   | —      | —       | Reserved                                                                                                 |
| 5   | —      | —       | Reserved                                                                                                 |
| 4   | R/W    | LDO4_EN | LDO4 Output Voltage Enable<br>0 = LDO4 Supply Output Disabled, Default<br>1 = LDO4 Supply Output Enabled |
| 3   | R/W    | LDO3_EN | LDO3 Output Voltage Enable<br>0 = LDO3 Supply Output Disabled, Default<br>1 = LDO3 Supply Output Enabled |
| 2   | R/W    | LDO2_EN | LDO2 Output Voltage Enable<br>0 = LDO2 Supply Output Disabled, Default<br>1 = LDO2 Supply Output Enabled |
| 1   | —      | —       | Reserved                                                                                                 |
| 0   | —      | —       | Reserved                                                                                                 |

**8.6.1.5 Output Voltage Status Register 2**
**8.6.1.5.1 Output Voltage Status Register 2 (OVS2) 8h'13**

| BIT         | 7      | 6   | 5   | 4       | 3       | 2       | 1   | 0   |
|-------------|--------|-----|-----|---------|---------|---------|-----|-----|
| Designation | LDO_OK | N/A | N/A | LDO4_OK | LDO3_OK | LDO2_OK | N/A | N/A |
| Reset Value | 0      | 0   | 0   | 0       | 0       | 0       | 0   | 0   |

**8.6.1.5.2 Output Voltage Status Register 2 (OVS2) 8h'13 Definitions**

| BIT | ACCESS | NAME    | DESCRIPTION                                                                                                                                                            |
|-----|--------|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | R      | LDO_OK  | LDOs 2-4 Supply Output Voltage Status<br>0 - (LDOs 2-4) output voltage < 90% of selected value<br>1 - (LDOs 2-4) output voltage > 90% of selected value                |
| 6   | —      | —       | Reserved                                                                                                                                                               |
| 5   | —      | —       | Reserved                                                                                                                                                               |
| 4   | R      | LDO4_OK | LDO4 Output Voltage Status<br>0 - (V <sub>CC_LDO4</sub> ) output voltage < 90% of selected value<br>1 - (V <sub>CC_LDO4</sub> ) output voltage > 90% of selected value |
| 3   | R      | LDO3_OK | LDO3 Output Voltage Status<br>0 - (V <sub>CC_LDO3</sub> ) output voltage < 90% of selected value<br>1 - (V <sub>CC_LDO3</sub> ) output voltage > 90% of selected value |

| BIT | ACCESS | NAME    | DESCRIPTION                                                                                                                                                  |
|-----|--------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2   | R      | LDO2_OK | LDO2 Output Voltage Status<br>0 - ( $V_{CC\_LDO2}$ ) output voltage < 90% of selected value<br>1 - ( $V_{CC\_LDO2}$ ) output voltage > 90% of selected value |
| 1   | —      | —       | Reserved                                                                                                                                                     |
| 0   | —      | —       | Reserved                                                                                                                                                     |

### 8.6.1.6 DVM Voltage Change Control Register 1

#### 8.6.1.6.1 DVM Voltage Change Control Register 1 ( $V_{CC1}$ ) 8h'20

| BIT         | 7   | 6   | 5   | 4   | 3        | 2 | 1   | 0   |
|-------------|-----|-----|-----|-----|----------|---|-----|-----|
| Designation | MVS | MGO | SVS | SGO | Reserved |   | AVS | AGO |
| Reset Value | 0   | 0   | 0   | 0   | 0        | 0 | 0   | 0   |

#### 8.6.1.6.2 DVM Voltage Change Control Register 1 ( $V_{CC1}$ ) 8h'20 Definitions

| BIT | ACCESS | NAME | DESCRIPTION                                                                                                                                                          |
|-----|--------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | R/W    | MVS  | $V_{CC\_MVT}$ (LDO1) Voltage Select<br>0 - Change $V_{CC\_MVT}$ Output Voltage to MDVT1<br>1 - Change $V_{CC\_MVT}$ Output Voltage to MDVT2                          |
| 6   | R/W    | MGO  | Start $V_{CC\_MVT}$ (LDO1) Voltage Change<br>0 - Hold $V_{CC\_MVT}$ Output Voltage at current Level<br>1 - Ramp $V_{CC\_MVT}$ Output Voltage as selected by MVS      |
| 5   | R/W    | SVS  | $V_{CC\_SRAM}$ (LDO5) Voltage Select<br>0 - Change $V_{CC\_SRAM}$ Output Voltage to SDTV1<br>1 - Change $V_{CC\_SRAM}$ Output Voltage to SDTV2                       |
| 4   | R/W    | SGO  | Start $V_{CC\_SRAM}$ (LDO5) Voltage Change<br>0 - Hold $V_{CC\_SRAM}$ Output Voltage at current Level<br>1 - Change $V_{CC\_SRAM}$ Output Voltage as selected by SVS |
| 3:2 | —      | —    | Reserved                                                                                                                                                             |
| 1   | R/W    | AVS  | $V_{CC\_APPS}$ (Buck1) Voltage Select<br>0 - Ramp $V_{CC\_APPS}$ Output Voltage to ADVT1<br>1 - Ramp $V_{CC\_APPS}$ Output Voltage to ADVT2                          |
| 0   | R/W    | AGO  | Start $V_{CC\_APPS}$ (Buck1) Voltage Change<br>0 - Hold $V_{CC\_APPS}$ Output Voltage at current Level<br>1 - Ramp $V_{CC\_APPS}$ Output Voltage as selected by AVS  |

### 8.6.1.7 Buck1 ( $V_{CC\_APPS}$ ) Voltage 1

#### 8.6.1.7.1 Buck1 ( $V_{CC\_APPS}$ ) Target Voltage 1 Register (ADTV1) 8h'23

| BIT         | 7        | 6 | 5 | 4 <sup>(1)</sup>             | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1 <sup>(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------|---|---|------------------------------|------------------|------------------|------------------|------------------|
| Designation | Reserved |   |   | Buck1 Output Voltage (B1OV1) |                  |                  |                  |                  |
| Reset Value | 0        | 0 | 0 | 0                            | 1                | 0                | 1                | 1                |

(1) One-time factory programmable

#### 8.6.1.7.2 Buck1 ( $V_{CC\_apps}$ ) Target Voltage 1 Register (ADTV1) 8h'23 Definitions

| BIT | ACCESS | NAME | DESCRIPTION |
|-----|--------|------|-------------|
| 7:5 | —      | —    | Reserved    |

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| BIT | ACCESS | NAME  | DESCRIPTION      |                       |                  |                       |
|-----|--------|-------|------------------|-----------------------|------------------|-----------------------|
| 4:0 | R/W    | B1OV1 | <b>Data Code</b> | <b>Output Voltage</b> | <b>Data Code</b> | <b>Output Voltage</b> |
|     |        |       | 5h'0             | 0.725                 | 5h'10            | 1.125                 |
|     |        |       | 5h'1             | 0.750                 | 5h'11            | 1.150                 |
|     |        |       | 5h'2             | 0.775                 | 5h'12            | 1.175                 |
|     |        |       | 5h'3             | 0.800                 | 5h'13            | 1.200                 |
|     |        |       | 5h'4             | 0.825                 | 5h'14            | 1.225                 |
|     |        |       | 5h'5             | 0.850                 | 5h'15            | 1.250                 |
|     |        |       | 5h'6             | 0.875                 | 5h'16            | 1.275                 |
|     |        |       | 5h'7             | 0.900                 | 5h'17            | 1.300                 |
|     |        |       | 5h'8             | 0.925                 | 5h'18            | 1.325                 |
|     |        |       | 5h'9             | 0.950                 | 5h'19            | 1.350                 |
|     |        |       | 5h'A             | 0.975                 | 5h'1A            | 1.375                 |
|     |        |       | 5h'B             | 1.000                 | 5h'1B (default)  | 1.400 (default)       |
|     |        |       | 5h'C             | 1.025                 | 5h'1C            | 1.425                 |
|     |        |       | 5h'D             | 1.050                 | 5h'1D            | 1.450                 |
|     |        |       | 5h'E             | 1.075                 | 5h'1E            | 1.475                 |
|     |        |       | 5h'F             | 1.100                 | 5h'1F            | 1.500                 |

**8.6.1.8 Buck1 (V<sub>CC\_APPS</sub>) Target Voltage 2 Register**
**8.6.1.8.1 Buck1 (V<sub>CC\_APPS</sub>) Target Voltage 2 Register (ADTV2) 8h'24**

| BIT         | 7        | 6 | 5 | 4                            | 3 | 2 | 1 | 0 |
|-------------|----------|---|---|------------------------------|---|---|---|---|
| Designation | Reserved |   |   | Buck1 Output Voltage (B1OV2) |   |   |   |   |
| Reset Value | 0        | 0 | 0 | 0                            | 1 | 0 | 1 | 1 |

**8.6.1.8.2 Buck1 (V<sub>CC\_APPS</sub>) Target Voltage 2 Register (ADTV2) 8h'24 Definitions**

| BIT | ACCESS | NAME  | DESCRIPTION      |                       |                  |                       |
|-----|--------|-------|------------------|-----------------------|------------------|-----------------------|
| 7:5 | —      | —     | Reserved         |                       |                  |                       |
| 4:0 | R/W    | B1OV2 | <b>Data Code</b> | <b>Output Voltage</b> | <b>Data Code</b> | <b>Output Voltage</b> |
|     |        |       | 5h'0             | 0.725                 | 5h'10            | 1.125                 |
|     |        |       | 5h'1             | 0.750                 | 5h'11            | 1.150                 |
|     |        |       | 5h'2             | 0.775                 | 5h'12            | 1.175                 |
|     |        |       | 5h'3             | 0.800                 | 5h'13            | 1.200                 |
|     |        |       | 5h'4             | 0.825                 | 5h'14            | 1.225                 |
|     |        |       | 5h'5             | 0.850                 | 5h'15            | 1.250                 |
|     |        |       | 5h'6             | 0.875                 | 5h'16            | 1.275                 |
|     |        |       | 5h'7             | 0.900                 | 5h'17            | 1.300                 |
|     |        |       | 5h'8             | 0.925                 | 5h'18            | 1.325                 |
|     |        |       | 5h'9             | 0.950                 | 5h'19            | 1.350                 |
|     |        |       | 5h'A             | 0.975                 | 5h'1A            | 1.375                 |
|     |        |       | 5h'B             | 1.000                 | 5h'1B            | 1.400                 |
|     |        |       | 5h'C             | 1.025                 | 5h'1C            | 1.425                 |
|     |        |       | 5h'D             | 1.050                 | 5h'1D            | 1.450                 |
|     |        |       | 5h'E             | 1.075                 | 5h'1E            | 1.475                 |
|     |        |       | 5h'F             | 1.100                 | 5h'1F            | 1.500                 |

**8.6.1.9 Buck1 (V<sub>CC\_APPS</sub>) Voltage Ramp Control Register**
**8.6.1.9.1 Buck1 (V<sub>CC\_APPS</sub>) Voltage Ramp Control Register (AVRC) 8h'25**

| BIT         | 7        | 6 | 5 | 4                | 3 | 2 | 1 | 0 |
|-------------|----------|---|---|------------------|---|---|---|---|
| Designation | Reserved |   |   | Ramp Rate (B1RR) |   |   |   |   |
| Reset Value | 0        | 0 | 0 | 0                | 1 | 0 | 1 | 0 |

**8.6.1.9.2 Buck1 (V<sub>CC\_APPS</sub>) Voltage Ramp Control Register (AVRC) 8h'25 Definitions**

| BIT | ACCESS | NAME | DESCRIPTION |
|-----|--------|------|-------------|
| 7:5 | —      | —    | Reserved    |

| BIT | ACCESS | NAME | DESCRIPTION      |                          |
|-----|--------|------|------------------|--------------------------|
| 4:0 | R/W    | B1RR | DVM Ramp Speed   |                          |
|     |        |      | <b>Data Code</b> | <b>Ramp Rate (mV/us)</b> |
|     |        |      | 5h'0             | Instant                  |
|     |        |      | 5h'1             | 1                        |
|     |        |      | 5h'2             | 2                        |
|     |        |      | 5h'3             | 3                        |
|     |        |      | 5h'4             | 4                        |
|     |        |      | 5h'5             | 5                        |
|     |        |      | 5h'6             | 6                        |
|     |        |      | 5h'7             | 7                        |
|     |        |      | 5h'8             | 8                        |
|     |        |      | 5h'9             | 9                        |
|     |        |      | 5h'A             | 10 (default)             |
|     |        |      | 4h'B-4h'1F       | Reserved                 |

#### 8.6.1.10 $V_{CC\_comm}$ Target Voltage 1 Dummy Register (CDTV1)

##### 8.6.1.10.1 $V_{CC\_comm}$ Target Voltage 1 Dummy Register (CDTV1) 8h'26 Write Only<sup>(1)</sup>

| BIT         | 7        | 6 | 5 | 4              | 3 | 2 | 1 | 0 |
|-------------|----------|---|---|----------------|---|---|---|---|
| Designation | Reserved |   |   | Output Voltage |   |   |   |   |
| Reset Value | 0        | 0 | 0 | 0              | 0 | 0 | 0 | 0 |

(1) CDTV1 must be writable by an I<sup>2</sup>C controller. This is a dummy register

#### 8.6.1.11 $V_{CC\_COMM}$ Target Voltage 2 Dummy Register (CDTV2)

##### 8.6.1.11.1 $V_{CC\_COMM}$ Target Voltage 2 Dummy Register (CDTV2) 8h'27 Write Only<sup>(1)</sup>

| BIT         | 7        | 6 | 5 | 4              | 3 | 2 | 1 | 0 |
|-------------|----------|---|---|----------------|---|---|---|---|
| Designation | Reserved |   |   | Output Voltage |   |   |   |   |
| Reset Value | 0        | 0 | 0 | 0              | 0 | 0 | 0 | 0 |

(1) CDTV2 must be writable by an I<sup>2</sup>C controller. This is a dummy register and cannot be read.

This is a variable voltage supply to the internal SRAM of the application processor.

#### 8.6.1.12 LDO5 ( $V_{CC\_SRAM}$ ) Target Voltage 1 Register

##### 8.6.1.12.1 LDO5 ( $V_{CC\_SRAM}$ ) Target Voltage 1 Register (SDTV1) 8h'29

| BIT         | 7        | 6 | 5 | 4 <sup>(1)</sup>            | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1 <sup>*(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------|---|---|-----------------------------|------------------|------------------|-------------------|------------------|
| Designation | Reserved |   |   | LDO 5 Output Voltage (L5OV) |                  |                  |                   |                  |
| Reset Value | 0        | 0 | 0 | 0                           | 1                | 0                | 1                 | 1                |

(1) One-time factory programmable EPROM registers for default values

##### 8.6.1.12.2 LDO5 ( $V_{CC\_SRAM}$ ) Target Voltage 1 Register (SDTV1) 8h'29 Definitions

| BIT | ACCESS | NAME | DESCRIPTION |
|-----|--------|------|-------------|
| 7:5 | —      | —    | Reserved    |

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| BIT | ACCESS | NAME | DESCRIPTION |                |                 |                 |
|-----|--------|------|-------------|----------------|-----------------|-----------------|
|     |        |      | Data Code   | Output Voltage | Data Code       | Output Voltage  |
| 4:0 | R/W    | B1OV | 5h'0        | —              | 5h'10           | 1.125           |
|     |        |      | 5h'1        | —              | 5h'11           | 1.150           |
|     |        |      | 5h'2        | —              | 5h'12           | 1.175           |
|     |        |      | 5h'3        | —              | 5h'13           | 1.200           |
|     |        |      | 5h'4        | —              | 5h'14           | 1.225           |
|     |        |      | 5h'5        | 0.850          | 5h'15           | 1.250           |
|     |        |      | 5h'6        | 0.875          | 5h'16           | 1.275           |
|     |        |      | 5h'7        | 0.900          | 5h'17           | 1.300           |
|     |        |      | 5h'8        | 0.925          | 5h'18           | 1.325           |
|     |        |      | 5h'9        | 0.950          | 5h'19           | 1.350           |
|     |        |      | 5h'A        | 0.975          | 5h'1A           | 1.375           |
|     |        |      | 5h'B        | 1.000          | 5h'1B (default) | 1.400 (default) |
|     |        |      | 5h'C        | 1.025          | 5h'1C           | 1.425           |
|     |        |      | 5h'D        | 1.050          | 5h'1D           | 1.450           |
|     |        |      | 5h'E        | 1.075          | 5h'1E           | 1.475           |
|     |        |      | 5h'F        | 1.100          | 5h'1F           | 1.500           |

### 8.6.1.13 LDO5 ( $V_{CC\_SRAM}$ ) Target Voltage 2 Register

#### 8.6.1.13.1 LDO5 ( $V_{CC\_SRAM}$ ) Target Voltage 2 Register (SDTV2) 8h'2A

| BIT         | 7        | 6 | 5 | 4                           | 3 | 2 | 1 | 0 |
|-------------|----------|---|---|-----------------------------|---|---|---|---|
| Designation | Reserved |   |   | LDO 5 Output Voltage (L5OV) |   |   |   |   |
| Reset Value | 0        | 0 | 0 | 0                           | 1 | 0 | 1 | 1 |

#### 8.6.1.13.2 LDO5 ( $V_{CC\_SRAM}$ ) Target Voltage 2 Register (SDTV2) 8h'2A Definitions

| BIT | ACCESS | NAME | DESCRIPTION      |                       |                  |                       |
|-----|--------|------|------------------|-----------------------|------------------|-----------------------|
| 7:5 | —      | —    | Reserved         |                       |                  |                       |
| 4:0 | R/W    | B1OV | <b>Data Code</b> | <b>Output Voltage</b> | <b>Data Code</b> | <b>Output Voltage</b> |
|     |        |      | 5h'0             | —                     | 5h'10            | 1.125                 |
|     |        |      | 5h'1             | —                     | 5h'11            | 1.150                 |
|     |        |      | 5h'2             | —                     | 5h'12            | 1.175                 |
|     |        |      | 5h'3             | —                     | 5h'13            | 1.200                 |
|     |        |      | 5h'4             | —                     | 5h'14            | 1.225                 |
|     |        |      | 5h'5             | 0.850                 | 5h'15            | 1.250                 |
|     |        |      | 5h'6             | 0.875                 | 5h'16            | 1.275                 |
|     |        |      | 5h'7             | 0.900                 | 5h'17            | 1.300                 |
|     |        |      | 5h'8             | 0.925                 | 5h'18            | 1.325                 |
|     |        |      | 5h'9             | 0.950                 | 5h'19            | 1.350                 |
|     |        |      | 5h'A             | 0.975                 | 5h'1A            | 1.375                 |
|     |        |      | 5h'B             | 1.000                 | 5h'1B            | 1.400                 |
|     |        |      | 5h'C             | 1.025                 | 5h'1C            | 1.425                 |
|     |        |      | 5h'D             | 1.050                 | 5h'1D            | 1.450                 |
|     |        |      | 5h'E             | 1.075                 | 5h'1E            | 1.475                 |
|     |        |      | 5h'F             | 1.100                 | 5h'1F            | 1.500                 |

$V_{CC\_MVT}$  is low tolerance regulated power supply for the application processor ring oscillator and logic for communicating to the LP3972.  $V_{CC\_MVT}$  is enabled when SYS\_EN is asserted and disabled when SYS\_EN is deasserted.

### 8.6.1.14 LDO1 ( $V_{CC\_MVT}$ ) Target Voltage 1 Register (MDTV1)

#### 8.6.1.14.1 LDO1 ( $V_{CC\_MVT}$ ) Target Voltage 1 Register (MDTV1) 8h'32

| BIT         | 7        | 6 | 5 | 4 <sup>(1)</sup>    | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1 <sup>(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------|---|---|---------------------|------------------|------------------|------------------|------------------|
| Designation | Reserved |   |   | Output Voltage (OV) |                  |                  |                  |                  |
| Reset Value | 0        | 0 | 0 | 0                   | 0                | 1                | 0                | 0                |

(1) One-time factory programmable EPROM registers for default values.

#### 8.6.1.14.2 LDO1 ( $V_{CC\_MVT}$ ) Target Voltage 1 Register (MDTV1) 8h'32 Definitions

| BIT | ACCESS | NAME | DESCRIPTION      |                       |               |
|-----|--------|------|------------------|-----------------------|---------------|
| 7:5 | —      | —    | Reserved         |                       |               |
| 4:0 | R/W    | L1OV | <b>Data Code</b> | <b>Output Voltage</b> | <b>Notes:</b> |
|     |        |      | 5h'0             | 1.700                 |               |
|     |        |      | 5h'1             | 1.725                 |               |
|     |        |      | 5h'2             | 1.750                 |               |
|     |        |      | 5h'3             | 1.775                 |               |
|     |        |      | 5h'4 (default)   | 1.800 (default)       |               |
|     |        |      | 5h'5             | 1.825                 |               |
|     |        |      | 5h'6             | 1.850                 |               |
|     |        |      | 5h'7             | 1.875                 |               |
|     |        |      | 5h'8             | 1.900                 |               |
|     |        |      | 5h'9             | 1.925                 |               |
|     |        |      | 5h'A             | 1.950                 |               |
|     |        |      | 5h'B             | 1.975                 |               |
|     |        |      | 5h'C             | 2.000                 |               |
|     |        |      | 5h'D-5h'F        | Reserved              |               |

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**8.6.1.15 LDO1 ( $V_{CC\_MVT}$ ) Target Voltage 2 Register**
**8.6.1.15.1 LDO1 ( $V_{CC\_MVT}$ ) Target Voltage 2 Register (MDTV2) 8h'33**

| BIT         | 7        | 6 | 5 | 4                   | 3 | 2 | 1 | 0 |
|-------------|----------|---|---|---------------------|---|---|---|---|
| Designation | Reserved |   |   | Output Voltage (OV) |   |   |   |   |
| Reset Value | 0        | 0 | 0 | 0                   | 1 | 0 | 1 | 1 |

**8.6.1.15.2 LDO1 ( $V_{CC\_MVT}$ ) Target Voltage 2 Register (MDTV2) 8h'33 Definitions**

| BIT | ACCESS | NAME | DESCRIPTION                                                                                                                                     |                                                                                                                                                                  |        |
|-----|--------|------|-------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------|
| 7:5 | —      | —    | Reserved                                                                                                                                        |                                                                                                                                                                  |        |
| 4:0 | R/W    | L1OV | <b>Data Code</b><br>5h'0<br>5h'1<br>5h'2<br>5h'3<br>5h'4 (default)<br>5h'5<br>5h'6<br>5h'7<br>5h'8<br>5h'9<br>5h'A<br>5h'B<br>5h'C<br>5h'D-5h'F | <b>Output Voltage</b><br>1.700<br>1.725<br>1.750<br>1.775<br>1.800 (default)<br>1.825<br>1.850<br>1.875<br>1.900<br>1.925<br>1.950<br>1.975<br>2.000<br>Reserved | Notes: |

**8.6.1.16 LDO2 Voltage Control Register (L12VCR)**
**8.6.1.16.1 LDO2 Voltage Control Register (L12VCR) 8h'39**

| BIT         | 7 <sup>(1)</sup>           | 6 <sup>(1)</sup> | 5 <sup>(1)</sup> | 4 <sup>(1)</sup> | 3        | 2 | 1 | 0 |
|-------------|----------------------------|------------------|------------------|------------------|----------|---|---|---|
| Designation | LDO2 Output Voltage (L2OV) |                  |                  |                  | Reserved |   |   |   |
| Reset Value | 0                          | 0                | 0                | 0                | 0        | 0 | 0 | 0 |

(1) One-time factory programmable EPROM registers for default values.

**8.6.1.16.2 LDO2 Voltage Control Register (L12VCR) 8h'39 Definitions**

| BIT | ACCESS | NAME | DESCRIPTION                                                                                                                                                |                                                                                                                                                 |
|-----|--------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:4 | R/W    | L2OV | <b>Data Code</b><br>4h'0 (default)<br>4h'1<br>4h'2<br>4h'3<br>4h'4<br>4h'5<br>4h'6<br>4h'7<br>4h'8<br>4h'9<br>4h'A<br>4h'B<br>4h'C<br>4h'D<br>4h'E<br>4h'F | <b>Output Voltage</b><br>1.8 (Default)<br>1.9<br>2.0<br>2.1<br>2.2<br>2.3<br>2.4<br>2.5<br>2.6<br>2.7<br>2.8<br>2.9<br>3.0<br>3.1<br>3.2<br>3.3 |
| 3:0 | —      | —    | Reserved                                                                                                                                                   |                                                                                                                                                 |

### 8.6.1.17 LDO4 – LDO3 Voltage Control Register (L34VCR)

#### 8.6.1.17.1 LDO4 – LDO3 Voltage Control Register (L34VCR) 8h'3A

| BIT         | 7 <sup>(1)</sup>           | 6 <sup>(1)</sup> | 5 <sup>(1)</sup> | 4 <sup>(1)</sup> | 3 <sup>(1)</sup>           | 2 <sup>(1)</sup> | 1 <sup>(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------------------------|------------------|------------------|------------------|----------------------------|------------------|------------------|------------------|
| Designation | LDO4 Output Voltage (L4OV) |                  |                  |                  | LDO3 Output Voltage (L3OV) |                  |                  |                  |
| Reset Value | 0                          | 0                | 0                | 0                | 0                          | 0                | 0                | 0                |

(1) One-time factory programmable EPROM registers for default values.

#### 8.6.1.17.2 LDO4 – LDO3 Voltage Control Register (L34VCR) 8h'3A Definitions

| BIT | ACCESS | NAME | DESCRIPTION      |                          |
|-----|--------|------|------------------|--------------------------|
| 7:4 | R/W    | L4OV | <b>Data Code</b> | <b>Output Voltage</b>    |
|     |        |      | 4h'0             | 1.00                     |
|     |        |      | 4h'1             | 1.05                     |
|     |        |      | 4h'2             | 1.10                     |
|     |        |      | 4h'3             | 1.15                     |
|     |        |      | 4h'4             | 1.20                     |
|     |        |      | 4h'5             | 1.25                     |
|     |        |      | 4h'6             | 1.30                     |
|     |        |      | 4h'7             | 1.35                     |
|     |        |      | 4h'8             | 1.40                     |
|     |        |      | 4h'9             | 1.50                     |
|     |        |      | 4h'A             | 1.80                     |
|     |        |      | 4h'B             | 1.90                     |
|     |        |      | 4h'C             | 2.50                     |
|     |        |      | 4h'D             | 2.80                     |
|     |        |      | 4h'E (default)   | 3.00 (default) (Default) |
|     |        |      | 4h'F             | 3.30                     |
| 3:0 | R/W    | L3OV | <b>Data Code</b> | <b>Output Voltage</b>    |
|     |        |      | 4h'0             | 1.8                      |
|     |        |      | 4h'1             | 1.9                      |
|     |        |      | 4h'2             | 2.0                      |
|     |        |      | 4h'3             | 2.1                      |
|     |        |      | 4h'4             | 2.2                      |
|     |        |      | 4h'5             | 2.3                      |
|     |        |      | 4h'6             | 2.4                      |
|     |        |      | 4h'7             | 2.5                      |
|     |        |      | 4h'8             | 2.6                      |
|     |        |      | 4h'9             | 2.7                      |
|     |        |      | 4h'A             | 2.8                      |
|     |        |      | 4h'B             | 2.9                      |
|     |        |      | 4h'C (default)   | 3.0 (Default)            |
|     |        |      | 4h'D             | 3.1                      |
|     |        |      | 4h'E             | 3.2                      |
|     |        |      | 4h'F             | 3.3                      |

## 8.6.2 TI-Defined Control and Status Registers

### 8.6.2.1 System Control Register 1 (SCR1)

#### 8.6.2.1.1 System Control Register 1 (SCR1) 8h'80

| BIT         | 7 <sup>(1)</sup> | 6 <sup>(1)</sup> | 5 <sup>(1)</sup> | 4     | 3     | 2     | 1         | 0       |
|-------------|------------------|------------------|------------------|-------|-------|-------|-----------|---------|
| Designation | BPSEN            | SENDL            |                  | FPWM3 | FPWM2 | FPWM1 | BK_SLOMOD | BK_SSEN |
| Reset Value | 0                | 1                | 0                | 0     | 0     | 0     | 0         | 0       |

(1) One-time factory programmable EPROM registers for default values.

#### 8.6.2.1.2 System Control Register 1 (SCR1) 8h'80 Definitions

| BIT | ACCESS | NAME      | DESCRIPTION                                                                                                                                                             |                                         |
|-----|--------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|
| 7   | R/W    | BPSEN     | Bypass System enable safety Lock. Prevents activation of PWR_EN when SYS_EN is low.<br>0 = PWR_EN "AND" with SYS_EN signal, Default<br>1 = PWR_EN independent of SYS_EN |                                         |
| 6:5 | R/W    | SENDL     | Delay time for High Voltage Power Domains LDO2, LDO3, LDO4, Buck2, and Buck3 after activation of SYS_EN. V <sub>CC</sub> _LDO1 has no delay.                            |                                         |
|     |        |           | Data Code                                                                                                                                                               | Delay (ms)                              |
|     |        |           | 2h'0<br>2h'1<br><b>2h'2</b><br>2h'3                                                                                                                                     | 0.0<br>0.5<br><b>1 (Default)</b><br>1.4 |
| 4   | R/W    | FPWM3     | Buck3 PWM/PFM Mode select<br>0 - Auto Switch between PFM and PWM operation<br>1 - PWM Mode Only does not switch to PFM                                                  |                                         |
| 3   | R/W    | FPWM2     | Buck2 PWM/PFM Mode select<br>0 - Auto Switch between PFM and PWM operation<br>1 - PWM Mode Only does not switch to PFM                                                  |                                         |
| 2   | R/W    | FPWM1     | Buck1 PWM/PFM Mode select<br>0 - Auto Switch between PFM and PWM operation<br>1 - PWM Mode Only does not switch to PFM                                                  |                                         |
| 1   | R      | BK_SLOMOD | Buck Spread Spectrum Modulation Bucks 1-3<br>0 = 10 kHz triangular wave spread spectrum modulation<br>1 = 2 kHz triangular wave spread spectrum modulation              |                                         |
| 0   | R      | BK_SSEN   | Spread spectrum function Bucks 1-3<br>0 = SS Output Disabled<br>1 = SS Output Enabled                                                                                   |                                         |

### 8.6.2.2 System Control Register 2 (SCR2)

#### 8.6.2.2.1 System Control Register 2 (SCR2) 8h'81

| BIT         | 7    | 6    | 5 <sup>(1)</sup> | 4    | 3     | 2 | 1     | 0 |
|-------------|------|------|------------------|------|-------|---|-------|---|
| Designation | BBCS | SHBU | BPTR             | WUP3 | GPIO2 |   | GPIO1 |   |
|             | 1    | 0    | 1                | 1    | 0     | 0 | 1     | 0 |

(1) One time factory programmable EPROM registers for default values.

#### 8.6.2.2.2 System Control Register 2 (SCR2) 8h'81 Definitions

| BIT | ACCESS | NAME | DESCRIPTION                                                                                                                                       |
|-----|--------|------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | R/W    | BBCS | Sets GPIO1 as control input for backup battery charger<br>0 - Backup battery Charger GPIO Disabled<br>1 - Backup battery Charger GPIO Pin Enabled |
| 6   | R/W    | SHBU | Shut down backup battery to prevent battery drain during shipping<br>0 = Backup Battery Enabled<br>1 = Backup battery Disabled                    |

| BIT | ACCESS | NAME                                                 | DESCRIPTION                                                                                                                               |
|-----|--------|------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------|
| 5   | R/W    | BPTR                                                 | Bypass LDO_RTC Output Voltage to LDO3 Output Voltage Tracking<br>0 - LDO_RTC3 Tracking enabled<br>1 - LDO_RTC3 Tracking disabled, Default |
| 4   | R/W    | WUP3                                                 | Spare Wake-up control input<br>0 - Active High<br>1 - Active Low                                                                          |
| 3:2 | R/W    | GPIO2                                                | Configure direction and output sense of GPIO2 Pin                                                                                         |
|     |        | <b>Data Code</b><br>2h'00<br>2h'01<br>2h'02<br>2h'03 | <b>GPIO2</b><br>Hi-Z<br>Output Low<br>Input<br>Output high                                                                                |
| 1:0 | R/W    | GPIO1                                                | Configure direction and output sense of GPIO1 Pin                                                                                         |
|     |        | <b>Data Code</b><br>2h'00<br>2h'01<br>2h'02<br>2h'03 | <b>GPIO1</b><br>Hi-Z<br>Output Low<br>Input<br>Output high                                                                                |

### 8.6.2.3 Output Enable 3 Register (OEN3) 8h'82

| BIT         | 7        | 6 | 5 | 4 <sup>(1)</sup> | 3      | 2 <sup>(1)</sup> | 1        | 0 <sup>(1)</sup> |
|-------------|----------|---|---|------------------|--------|------------------|----------|------------------|
| Designation | Reserved |   |   | B3EN             | ENFLAG | B2EN             | Reserved | L1EN             |
| Reset Value | 0        | 0 | 0 | 1                | 0      | 1                | 0        | 1                |

(1) One time factory programmable EPROM registers for default values.

### 8.6.2.4 Output Enable 3 Register (OEN3) 8h'82 Definitions

| BIT | ACCESS | NAME   | DESCRIPTION                                                                                                                                                 |
|-----|--------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7:5 | —      | —      | Reserved                                                                                                                                                    |
| 4   | R/W    | B3EN   | V <sub>CC_Buck3</sub> Supply Output Enabled<br>0 = V <sub>CC_Buck3</sub> Supply Output Disabled<br>1 = V <sub>CC_Buck3</sub> Supply Output Enabled, Default |
| 3   | R/W    | ENFLAG | Enable for Temperature Flags (BCT)<br>0 = Temperature Flag Disabled<br>1 = Temperature Flag Enabled                                                         |
| 2   | R/W    | B2EN   | V <sub>CC_Buck2</sub> Supply Output Enabled<br>0 = V <sub>CC_Buck2</sub> Supply Output Disabled<br>1 = V <sub>CC_Buck2</sub> Supply Output Enabled, Default |
| 1   | —      | —      | Reserved                                                                                                                                                    |
| 0   | R/W    | L1EN   | LDO1 (MVT) Output Voltage Enable<br>0 = LDO1 Supply Output Disabled<br>1 = LDO1 Supply Output Enabled, Default                                              |

### 8.6.2.5 Status Register 3 (OSR3) 8h'83

| BIT         | 7     | 6     | 5     | 4       | 3        | 2    | 1    | 0    |
|-------------|-------|-------|-------|---------|----------|------|------|------|
| Designation | BT_OK | B3_OK | B2_OK | LDO1_OK | Reserved | BCT2 | BCT1 | BCT0 |
| Reset Value | 0     | 0     | 0     | 0       | 0        | 0    | 0    | 0    |

### 8.6.2.6 Status Register 3 (OSR3) Definitions 8h'83

| BIT | ACCESS | NAME  | DESCRIPTION                                                                                                                                        |
|-----|--------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | R      | BT_OK | Bucks 2-3 Supply Output Voltage Status<br>0 - (Bucks 1-3) output voltage < 90% Default value<br>1 - (Bucks 1-3) output voltage > 90% Default value |

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| BIT | ACCESS | NAME    | DESCRIPTION                                                                                                                                                            |  |  |
|-----|--------|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|
| 6   | R      | B3_OK   | Buck3 Supply Output Voltage Status<br>0 - (Buck3) output voltage < 90% Default value<br>1 - (Buck3) output voltage > 90% Default value                                 |  |  |
| 5   | R      | B2_OK   | Buck2 Supply Output Voltage Status<br>0 - (Buck2) output voltage < 90% Default value<br>1 - (Buck2) output voltage > 90% Default value                                 |  |  |
| 4   | R      | LDO1_OK | LDO1 Output Voltage Status<br>0 - (V <sub>CC_LDO1</sub> ) output voltage < 90% of selected value<br>1 - (V <sub>CC_LDO1</sub> ) output voltage > 90% of selected value |  |  |
| 3   | —      | —       | Reserved                                                                                                                                                               |  |  |
| 2:0 | R      | BCT     | Binary coded thermal management flag status register                                                                                                                   |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |
|     |        |         |                                                                                                                                                                        |  |  |

**8.6.2.7 Logic Output Enable Register (LOER) 8h'84**

| BIT         | 7        | 6 <sup>(1)</sup> | 5 <sup>(1)</sup> | 4 <sup>(1)</sup> | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1 <sup>(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------|------------------|------------------|------------------|------------------|------------------|------------------|------------------|
| Designation | Reserved | B3ENC            | B2ENC            | B1ENC            | L5EC             | L4EC             | L3EC             | L2EC             |
| Reset Value | 0        | 1                | 1                | 0                | 0                | 1                | 1                | 1                |

(1) One time factory programmable EPROM registers for default values.

**8.6.2.8 Logic Output Enable Register (LOER) Definitions 8h'84**

| BIT | ACCESS | NAME  | DESCRIPTION                                                                                                                                          |
|-----|--------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7   | —      | —     | Reserved                                                                                                                                             |
| 6   | R/W    | B3ENC | Connects Buck3 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - Buck3 enable connected to PWR_EN<br>1 - Buck3 enable connected to SYS_EN, Default |
| 5   | R/W    | B2ENC | Connects Buck2 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - Buck2 enable connected to PWR_EN<br>1 - Buck2 enable connected to SYS_EN, Default |
| 4   | R/W    | B1ENC | Connects Buck1 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - Buck1 enable connected to PWR_EN, Default<br>1 - Buck1 enable connected to SYS_EN |
| 3   | R/W    | L5EC  | Connects LDO5 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - LDO5 enable connected to PWR_EN, Default<br>1 - LDO5 enable connected to SYS_EN    |
| 2   | R/W    | L4EC  | Connects LDO4 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - LDO4 enable connected to PWR_EN<br>1 - LDO4 enable connected to SYS_EN, Default    |
| 1   | R/W    | L3EC  | Connects LDO3 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - LDO3 enable connected to PWR_EN<br>1 - LDO3 enable connected to SYS_EN, Default    |
| 0   | R/W    | L2EC  | Connects LDO2 enable to SYS_EN or PWR_EN Logic Control pin<br>0 - LDO2 enable connected to PWR_EN<br>1 - LDO2 enable connected to SYS_EN, Default    |

### 8.6.2.9 $V_{CC}$ BUCK2 Target Voltage Register (B2TV) 8h'85

| Bit         | 7        | 6 | 5 | 4 <sup>(1)</sup>            | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1 <sup>(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------|---|---|-----------------------------|------------------|------------------|------------------|------------------|
| Designation | Reserved |   |   | Buck2 Output Voltage (B2OV) |                  |                  |                  |                  |
| Reset Value | 0        | 0 | 0 | 1                           | 1                | 0                | 0                | 1                |

(1) One time factory programmable EPROM registers for default values.

### 8.6.2.10 $V_{CC}$ BUCK2 Target Voltage Register (B2TV) 8h'85 Definitions

| Bit | Access | Name | Description      |            |                  |                |
|-----|--------|------|------------------|------------|------------------|----------------|
| 7:5 | —      |      | Reserved         |            |                  |                |
| 4:0 | R/W    | B2OV | Output Voltage   |            |                  |                |
|     |        |      | <b>Data Code</b> | <b>(V)</b> | <b>Data Code</b> | <b>(V)</b>     |
|     |        |      | 5h'01            | 0.80       | 5h'0D            | 1.40           |
|     |        |      | 5h'02            | 0.85       | 5h'0E            | 1.45           |
|     |        |      | 5h'03            | 0.90       | 5h'0F            | 1.50           |
|     |        |      | 5h'04            | 0.95       | 5h'10            | 1.55           |
|     |        |      | 5h'05            | 1.00       | 5h'11            | 1.60           |
|     |        |      | 5h'06            | 1.05       | 5h'12            | 1.65           |
|     |        |      | 5h'07            | 1.10       | 5h'13            | 1.70           |
|     |        |      | 5h'08            | 1.15       | 5h'14            | 1.80           |
|     |        |      | 5h'09            | 1.20       | 5h'15            | 1.90           |
|     |        |      | 5h'0A            | 1.25       | 5h'16            | 2.50           |
|     |        |      | 5h'0B            | 1.30       | 5h'17            | 2.80           |
|     |        |      | 5h'0C            | 1.35       | 5h'18            | 3.00           |
|     |        |      |                  |            | 5h'19 (default)  | 3.30 (default) |

### 8.6.2.11 BUCK3 Target Voltage Register (B3TV) 8h'86

| Bit         | 7        | 6 | 5 | 4 <sup>(1)</sup>            | 3 <sup>(1)</sup> | 2 <sup>(1)</sup> | 1 <sup>(1)</sup> | 0 <sup>(1)</sup> |
|-------------|----------|---|---|-----------------------------|------------------|------------------|------------------|------------------|
| Designation | Reserved |   |   | Buck3 Output Voltage (B3OV) |                  |                  |                  |                  |
| Reset Value | 0        | 0 | 0 | 1                           | 0                | 1                | 0                | 0                |

(1) One time factory programmable EPROM registers for default values.

### 8.6.2.12 BUCK3 Target Voltage Register (B3TV) 8h'86 Definitions

| Bit | Access | Name | Description      |            |                  |                |
|-----|--------|------|------------------|------------|------------------|----------------|
| 7:5 | —      |      | Reserved         |            |                  |                |
| 4:0 | R/W    | B3OV | Output Voltage   |            |                  |                |
|     |        |      | <b>Data Code</b> | <b>(V)</b> | <b>Data Code</b> | <b>(V)</b>     |
|     |        |      | 5h'01            | 0.80       | 5h'0D            | 1.40           |
|     |        |      | 5h'02            | 0.85       | 5h'0E            | 1.45           |
|     |        |      | 5h'03            | 0.90       | 5h'0F            | 1.50           |
|     |        |      | 5h'04            | 0.95       | 5h'11            | 1.60           |
|     |        |      | 5h'05            | 1.00       | 5h'12            | 1.65           |
|     |        |      | 5h'06            | 1.05       | 5h'13            | 1.70           |
|     |        |      | 5h'07            | 1.10       | 5h'14 (default)  | 1.80 (default) |
|     |        |      | 5h'08            | 1.15       | 5h'15            | 1.90           |
|     |        |      | 5h'09            | 1.20       | 5h'16            | 2.50           |
|     |        |      | 5h'0A            | 1.25       | 5h'17            | 2.80           |
|     |        |      | 5h'0B            | 1.30       | 5h'18            | 3.00           |
|     |        |      | 5h'0C            | 1.35       | 5h'19            | 3.30           |

### 8.6.2.13 $V_{CC}$ BUCK3:2 Voltage Ramp Control Register (B32RC)

#### 8.6.2.13.1 $V_{CC}$ BUCK3:2 Voltage Ramp Control Register (B32RC) 8h'87

| Bit         | 7                | 6 | 5 | 4 | 3                | 2 | 1 | 0 |
|-------------|------------------|---|---|---|------------------|---|---|---|
| Designation | Ramp Rate (B3RR) |   |   |   | Ramp Rate (B2RR) |   |   |   |
| Reset Value | 1                | 0 | 1 | 0 | 1                | 0 | 1 | 0 |

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[www.ti.com](http://www.ti.com)
**8.6.2.13.2 Buck3:2 Voltage Ramp Control Register (B3RC) 8h'87 Definitions**

| Bit | Access | Name | Description      |                        |
|-----|--------|------|------------------|------------------------|
| 7:4 | R/W    | B3RR | <b>Data Code</b> | <b>Ramp Rate mV/μS</b> |
|     |        |      | 4h'0             | Instant                |
|     |        |      | 4h'1             | 1                      |
|     |        |      | 4h'2             | 2                      |
|     |        |      | 4h'3             | 3                      |
|     |        |      | 4h'4             | 4                      |
|     |        |      | 4h'5             | 5                      |
|     |        |      | 4h'6             | 6                      |
|     |        |      | 4h'7             | 7                      |
|     |        |      | 4h'8             | 8                      |
|     |        |      | 4h'9             | 9                      |
|     |        |      | 4h'A             | 10                     |
| 3:0 | R/W    | B2RR | <b>Data Code</b> | <b>Ramp Rate mV/μS</b> |
|     |        |      | 4h'0             | Instant                |
|     |        |      | 4h'1             | 1                      |
|     |        |      | 4h'2             | 2                      |
|     |        |      | 4h'3             | 3                      |
|     |        |      | 4h'4             | 4                      |
|     |        |      | 4h'5             | 5                      |
|     |        |      | 4h'6             | 6                      |
|     |        |      | 4h'7             | 7                      |
|     |        |      | 4h'8             | 8                      |
|     |        |      | 4h'9             | 9                      |
|     |        |      | 4h'A (default)   | 10 (default)           |

**8.6.2.14 Interrupt Status Register ISRA**

This register specifies the status bits for the interrupts generated by the LP3972 device.

**8.6.2.14.1 Interrupt Status Register ISRA 8h'88**

| Bit         | 7        | 6    | 5    | 4    | 3    | 2    | 1    | 0    |
|-------------|----------|------|------|------|------|------|------|------|
| Designation | Reserved | T125 | GPI2 | GPI1 | WUP3 | WUP2 | WUPT | WUPS |
| Reset Value | 0        | 0    | 0    | 0    | 0    | 0    | 0    | 0    |

**8.6.2.14.2 Interrupt Status Register ISRA 8h'88 Definitions**

| Bit | Access | Name | Description                                                                                                 |
|-----|--------|------|-------------------------------------------------------------------------------------------------------------|
| 7   | —      | —    | Reserved                                                                                                    |
| 6   | R      | T125 | Status bit for thermal warning PMIC T>125°C<br>0 = PMIC Temp. < 125°C<br>1 = PMIC Temp. > 125°C             |
| 5   | R      | GPI2 | Status bit for the input read in from GPIO 2 when set as Input<br>0 = GPI2 Logic Low<br>1 = GPI2 Logic High |
| 4   | R      | GPI1 | Status bit for the input read in from GPIO 1 when set as Input<br>0 = GPI1 Logic Low<br>1 = GPI1 Logic High |
| 3   | R      | WUP3 | PWR_ON Pin long pulse wake-up status<br>0 = No wake-up event<br>1 = Long pulse wake-up event                |
| 2   | R      | WUP2 | PWR_ON Pin Short pulse wake-up Status<br>0 = No wake-up event<br>1 = Short pulse wake-up event              |
| 1   | R      | WUPT | TEST_JIG Pin wake-up Status<br>0 = No wake-up event<br>1 = Wake-up event                                    |
| 0   | R      | WUPS | SPARE pin wake-up status<br>0 = No wake-up event<br>1 = Wake-up event                                       |

### 8.6.2.15 Backup Battery Charger Control Register (BCCR)

This register specifies the status of the main battery supply (NBUB bit).

#### 8.6.2.15.1 Backup Battery Charger Control Register (BCCR) 8h'89

| Bit         | 7 <sup>(1)</sup> | 6     | 5 <sup>(1)</sup> | 4 <sup>(1)</sup> | 3 <sup>(1)</sup> | 2     | 1    | 0 |
|-------------|------------------|-------|------------------|------------------|------------------|-------|------|---|
| Designation | NBUB             | CNBFL | nBFLT            |                  |                  | BUCEN | IBUC |   |
| Reset Value | 0                | 0     | 0                | 1                | 0                | 0     | 0    | 1 |

(1) One-time factory programmable EPROM registers for default values.

#### 8.6.2.15.2 Backup Battery Charger Control Register (BCCR) 8h'89 Definitions

| Bit   | Access | Name  | Description                                                                                                                                                  |                          |                    |
|-------|--------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|--------------------|
| 7     | R/W    | NBUB  | No backup battery default setting. Logic does not allow switch-over to backup battery.<br>0 = Backup Battery Enabled, Default<br>1 = Backup Battery Disabled |                          |                    |
| 6     | R/W    | CNBFL | Control for nBATT_FLT output signal<br>0 = nBATT_FLT Enabled<br>1 = nBATT_FLT Disabled                                                                       |                          |                    |
| 5:3   | R/W    | BFLT  | nBATT_FLT monitors the battery voltage and can be set to the Assert voltages listed below.                                                                   |                          |                    |
|       |        |       | <b>Data Code</b>                                                                                                                                             | <b>Asserted</b>          | <b>De-Asserted</b> |
|       |        |       | 3h'01                                                                                                                                                        | 2.6                      | 2.8                |
|       |        |       | 3h'02                                                                                                                                                        | 2.8 (default)            | 3.0 (Default)      |
|       |        |       | 3h'03                                                                                                                                                        | 3.0                      | 3.2                |
|       |        |       | 3h'04                                                                                                                                                        | 3.2                      | 3.4                |
| 3h'05 | 3.4    | 3.6   |                                                                                                                                                              |                          |                    |
| 2     | R/W    | BUCEN | Enables backup battery charger<br>0 = Backup Battery Charger Disabled<br>1 = Backup Battery Charger Enabled                                                  |                          |                    |
| 1:0   | R/W    | IBUC  | Charger current setting for backup battery                                                                                                                   |                          |                    |
|       |        |       | <b>Data Code</b>                                                                                                                                             | <b>BU Charger I (μA)</b> |                    |
|       |        |       | 2h'00                                                                                                                                                        | 260                      |                    |
|       |        |       | 2h'01 (default)                                                                                                                                              | 190 (Default)            |                    |
|       |        |       | 2h'02                                                                                                                                                        | 325                      |                    |
| 2h'03 | 390    |       |                                                                                                                                                              |                          |                    |

### 8.6.2.16 Marvell PXA Internal 1 Revision Register (II1RR) 8h'8E

| Bit         | 7     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------|---|---|---|---|---|---|---|
| Designation | II1RR |   |   |   |   |   |   |   |
| Reset Value | 0     | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

#### 8.6.2.17 Marvell PXA Internal 1 Revision Register (II1RR) (II1rr) 8h'8E Definitions

| Bit | Access | Name  | Description                                             |
|-----|--------|-------|---------------------------------------------------------|
| 7:0 | R      | II1RR | Intel internal usage register for revision information. |

### 8.6.2.18 Marvell PXA Internal 2 Revision Register (II2RR) 8h'8F

| Bit         | 7     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------------|-------|---|---|---|---|---|---|---|
| Designation | II2RR |   |   |   |   |   |   |   |
| Reset Value | 0     | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

### 8.6.2.19 Marvell PXA Internal 2 Revision Register (II1RR) 8h'8F Definitions

| Bit | Access | Name  | Description                                             |
|-----|--------|-------|---------------------------------------------------------|
| 7:0 | R      | II2RR | Intel internal usage register for revision information. |

### 8.6.2.20 Register Programming Examples

#### 8.6.2.20.1 Example 1: Start-of-Day (SOD) Sequence

| PMIC Register Address | PMIC Register Name | Register Data | Description                                                           |
|-----------------------|--------------------|---------------|-----------------------------------------------------------------------|
| 8h'23                 | ADTVI              | 00011011      | Sets the SOD $V_{CC\_APPS}$ voltage                                   |
| 8h'29                 | SDTV1              | 00011011      | Sets the SOD $V_{CC\_SRAM}$ voltage                                   |
| 8h'10                 | OVER1              | 00000111      | Enables $V_{CC\_SRAM}$ and $V_{CC\_APPS}$ to their programmed values. |

SODI multi-byte random register transfer is shown in [Figure 25](#):

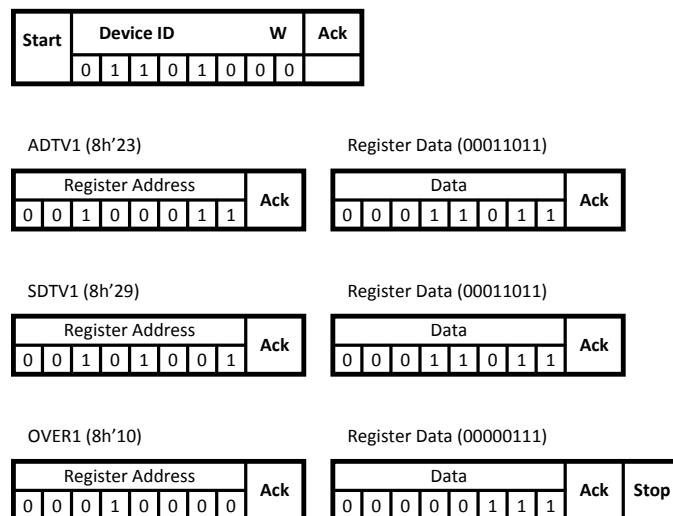


**Figure 25. SOD Multi-Byte Random Register Transfer**

|                |                                                                                                                                                                                                                    |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Device Address | Register A Address, Ach,<br>Register A Data, Ach<br>Register M Address, Ach,<br>Register M Data, Ach<br>Register X Address, Ach,<br>Register X Data, Ach<br>Register Z Address, Ach,<br>Register Z Data, Ach, Stop |
|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|

#### 8.6.2.20.2 Example 2: Voltage Change Sequence

| PMIC Register Address | PMIC Register Name | Register Data | Description                                                                            |
|-----------------------|--------------------|---------------|----------------------------------------------------------------------------------------|
| 8h'24                 | ADTV2              | 00010111      | Sets the $V_{CCAPPS\_}$ target voltage 2 to 1.3 V.                                     |
| 8h'2A                 | SDTV2              | 00001111      | Sets the $V_{CC\_SRAM}$ target voltage 2 to 1.1 V.                                     |
| 8h'20                 | $V_{CC1}$          | 00110011      | Enables $V_{CC\_SRAM}$ and $V_{CC\_APPS}$ to change to their programmed target values. |

### 8.6.2.20.3 I<sup>2</sup>C Data Exchange Between Master and Slave Device

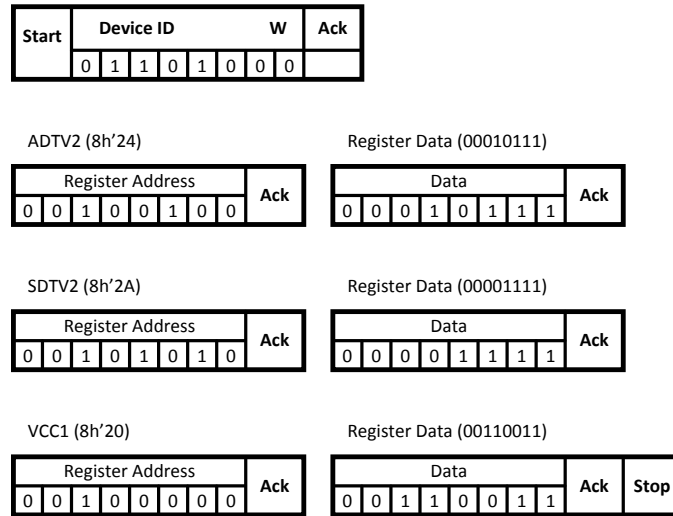


**Figure 26. Master and Slave Data Exchange**

## 9 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 9.1 Application Information

The LP3972 is designed for powering systems that use advanced application processors. The device is specifically optimized for lower power handheld applications using Lithium-Ion main battery, DC chargers, and battery backup. The device is internally powered from the VIN and VDDA pins, and voltage must be in 2.7-V to 5.5-V range. The device has flexible configurability; output supply voltages and start-up delays for the buck converters and LDOs are configured via I<sup>2</sup>C registers.

### 9.2 Typical Application

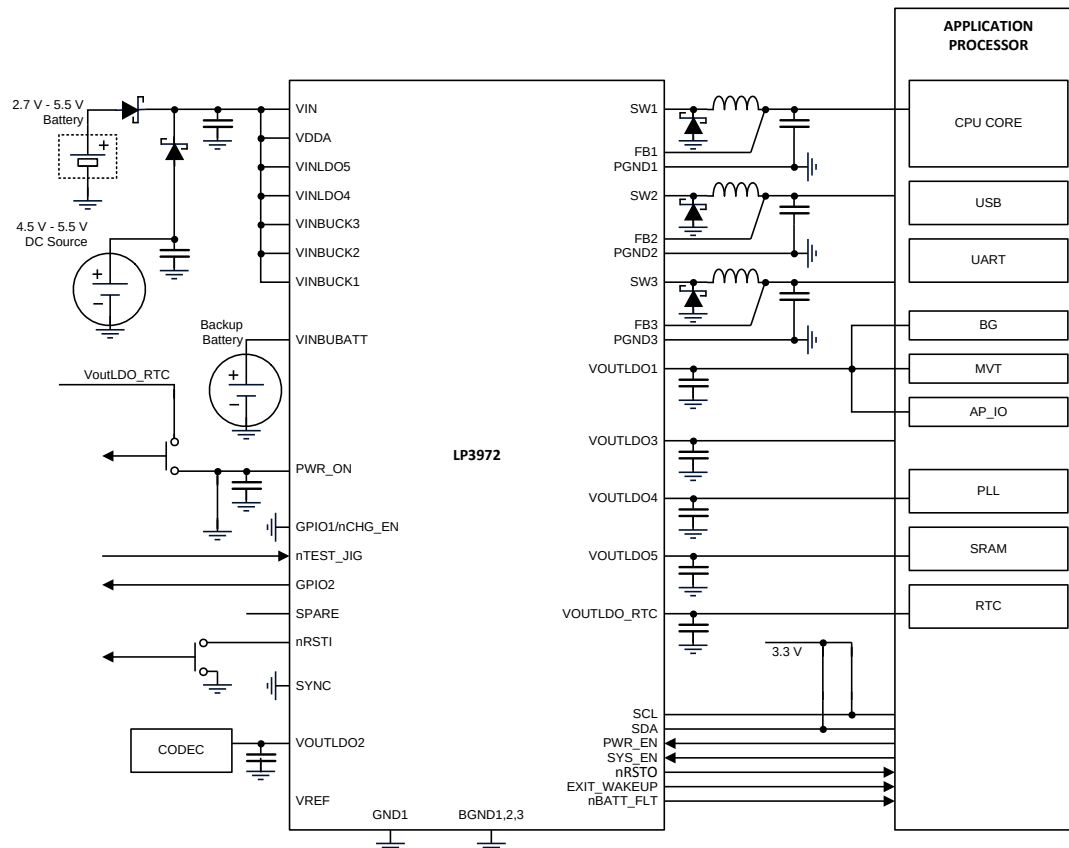


**Figure 27. LP3972 Typical Application**

## Typical Application (continued)

### 9.2.1 Design Requirements

For typical PMU advanced application processor applications, use the parameters listed in [Table 10](#).

**Table 10. Design Parameters**

| DESIGN PARAMETER              | EXAMPLE VALUE                        |
|-------------------------------|--------------------------------------|
| Minimum input voltage         | 2.7                                  |
| Maximum input voltage         | 5.5                                  |
| External SYNC clock used      | No                                   |
| LDO RTC output voltage        | 2.8 V                                |
| LDO1 output voltage           | 1.8 V                                |
| LDO2 output voltage           | 1.8 V                                |
| LDO3 output voltage           | 3 V                                  |
| LDO4 output voltage           | 3 V                                  |
| LDO5 output voltage           | 1.4 V                                |
| BUCK1 output voltage          | 1.4 V                                |
| BUCK2 output voltage          | 3.3 V                                |
| BUCK3 output voltage          | 1.8 V                                |
| Low voltage designated rails  | LDO5, BUCK1                          |
| High voltage designated rails | LDO1, LDO2, LDO3, LDO4, BUCK2, BUCK3 |

### 9.2.2 Detailed Design Procedure

#### 9.2.2.1 LDO Considerations

##### 9.2.2.1.1 External Capacitors

Regulators of the LP3972 require external capacitors for regulator stability. These are specifically designed for portable applications requiring minimum board space and smallest components. These capacitors must be correctly selected for good performance.

##### 9.2.2.1.2 Input Capacitor

An input capacitor is required for stability. It is recommended that a 1- $\mu$ F capacitor be connected between the LDO input pin and ground (this capacitance value may be increased without limit).

This capacitor must be located a distance of not more than 1 cm from the input pin and returned to a clean analogue ground. Any good quality ceramic, tantalum, or film capacitor may be used at the input.

#### NOTE

Tantalum capacitors can suffer catastrophic failures due to surge current when connected to a low impedance source of power (like a battery or a very large capacitor). If a tantalum capacitor is used at the input, it must be ensured by the manufacturer to have a surge current rating sufficient for the application.

There are no requirements for the equivalent series resistance (ESR) on the input capacitor, but tolerance and temperature coefficient must be considered when selecting the capacitor to ensure the capacitance remains approximately 1  $\mu$ F over the entire operating temperature range.

##### 9.2.2.1.3 Output Capacitor

The LDOs are designed specifically to work with very small ceramic output capacitors. A 1- $\mu$ F ceramic capacitor (temperature types Z5U, Y5V or X7R) with ESR between 5 m $\Omega$  to 500 m $\Omega$ , are suitable in the application circuit.

For this device the output capacitor must be connected between the  $V_{OUT}$  pin and ground.

It is also possible to use tantalum or film capacitors at the device output,  $C_{OUT}$  (or  $V_{OUT}$ ), but these are not as attractive for reasons of size and cost (see [Capacitor Characteristics](#)).

The output capacitor must meet the requirement for the minimum value of capacitance and also have an ESR value that is within the range 5 m $\Omega$  to 500 m $\Omega$  for stability.

#### 9.2.2.1.4 No-Load Stability

The LDOs remain stable and in regulation with no external load. This is an important consideration in some circuits, for example CMOS RAM keep-alive applications.

#### 9.2.2.1.5 Capacitor Characteristics

The LDOs are designed to work with ceramic capacitors on the output to take advantage of the benefits they offer. For capacitance values in the range of 0.47  $\mu$ F to 4.7  $\mu$ F, ceramic capacitors are the smallest, least expensive and have the lowest ESR values, thus making them best for eliminating high frequency noise. The ESR of a typical 1- $\mu$ F ceramic capacitor is in the range of 20 m $\Omega$  to 40 m $\Omega$ , which easily meets the ESR requirement for stability for the LDOs.

For both input and output capacitors, careful interpretation of the capacitor specification is required to ensure correct device operation. The capacitor value can change greatly, depending on the operating conditions and capacitor type. In particular, the output capacitor selection must take account of all the capacitor parameters, to ensure that the specification is met within the application. The capacitance can vary with DC bias conditions as well as temperature and frequency of operation. Capacitor values may also show some decrease over time due to aging. The capacitor parameters are also dependant on the particular case size, with smaller sizes giving poorer performance figures in general. As an example, [Figure 28](#) shows a typical graph comparing different capacitor case sizes. As shown in [Figure 28](#), increasing the DC bias condition can result in the capacitance value falling below the minimum value given in the recommended capacitor specifications table. Note that the graph shows the capacitance out of spec for the 0402 case size capacitor at higher bias voltages. It is therefore recommended that the capacitor manufacturers' specifications for the nominal value capacitor are consulted for all conditions, as some capacitor sizes (for example, 0402) may not be suitable in the actual application.

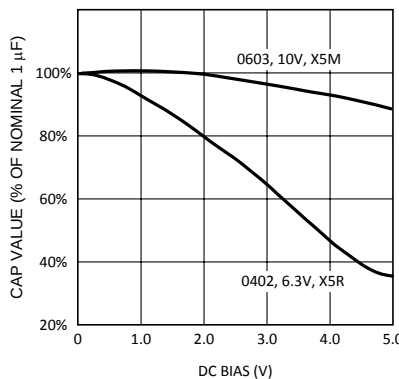


**Figure 28. Typical Variation in Capacitance vs DC Bias**

Capacitance of the ceramic capacitor can vary with temperature. The capacitor type X7R, which operates over a temperature range of  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ , only varies the capacitance to within  $\pm 15\%$ . The capacitor type X5R has a similar tolerance over a reduced temperature range of  $-55^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ . Many large value ceramic capacitors, larger than 1  $\mu$ F are manufactured with Z5U or Y5V temperature characteristics. Their capacitance can drop by more than 50% as the temperature varies from  $25^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ . Therefore X7R is recommended over Z5U and Y5V in applications where the ambient temperature changes significantly above or below  $25^{\circ}\text{C}$ .

Tantalum capacitors are less desirable than ceramic for use as output capacitors because they are more expensive when comparing equivalent capacitance and voltage ratings in the 0.47- $\mu$ F to 4.7- $\mu$ F range.

Another important consideration is that tantalum capacitors have higher ESR values than equivalent size ceramics. This means that while it may be possible to find a tantalum capacitor with an ESR value within the stable range, it would have to be larger in capacitance (which means bigger and more costly) than a ceramic capacitor with the same ESR value. The ESR of a typical tantalum increases about 2:1 as the temperature goes from  $25^{\circ}\text{C}$  down to  $-40^{\circ}\text{C}$ , so some guard band must be allowed.

### 9.2.2.2 Buck Considerations

#### 9.2.2.2.1 Inductor Selection

There are two main considerations when choosing an inductor; the inductor must not saturate, and the inductor current ripple is small enough to achieve the desired output voltage ripple. Different saturation current rating specificationss are followed by different manufacturers so attention must be given to details. Saturation current ratings are typically specified at 25°C so ratings at maximum ambient temperature of application should be requested from manufacturer.

There are two methods to choose the inductor saturation current rating.

##### 9.2.2.2.1.1 Method 1

The saturation current is greater than the sum of the maximum load current and the worst case average to peak inductor current ([Equation 2](#)):

$$I_{SAT} > I_{OUTMAX} + I_{RIPPLE}$$

$$\text{where } I_{RIPPLE} = \left( \frac{V_{IN} - V_{OUT}}{2 * L} \right) * \left( \frac{V_{OUT}}{V_{IN}} \right) * \left( \frac{1}{f} \right)$$

where

- $I_{RIPPLE}$ : Average to peak inductor current
- $I_{OUTMAX}$ : Maximum load current (1500 mA)
- $V_{IN}$ : Maximum input voltage in application
- $L$ : Minimum inductor value including worst case tolerances (30% drop can be considered for [Method 1](#))
- $f$ : Minimum switching frequency (1.6 MHz)
- $V_{OUT}$ : Output voltage

(2)

##### 9.2.2.2.1.2 Method 2

A more conservative and recommended approach is to choose an inductor that has saturation current rating greater than the maximum current limit of 3 A.

A 2.2-μH inductor with a saturation current rating of at least 3 A is recommended for most applications. Resistance of the inductor must be less than 0.3 Ω for a good efficiency. [Table 11](#) lists suggested inductors and suppliers. For low-cost applications, an unshielded bobbin inductor could be considered. For noise critical applications, a toroidal or shielded bobbin inductor should be used. A good practice is to lay out the board with overlapping footprints of both types for design flexibility. This allows substitution of a low-noise shielded inductor, in the event that noise from low-cost bobbin models is unacceptable.

#### 9.2.2.2.2 Input Capacitor Selection

A ceramic input capacitor of 10 μF, 6.3 V is sufficient for most applications. Place the input capacitor as close as possible to the VIN pin of the device. A larger value may be used for improved input voltage filtering. Use X7R or X5R types, do not use Y5V. DC bias characteristics of ceramic capacitors must be considered when selecting case sizes like 0805 and 0603. The input filter capacitor supplies current to the PFET switch of the converter in the first half of each cycle and reduces voltage ripple imposed on the input power source. A ceramic capacitor's low ESR provides the best noise filtering of the input voltage spikes due to this rapidly changing current. Select a capacitor with sufficient ripple current rating. The input current ripple can be calculated as in [Equation 3](#):

$$I_{RMS} = I_{OUTMAX} * \sqrt{\frac{V_{OUT}}{V_{IN}} * \left( 1 - \frac{V_{OUT}}{V_{IN}} + \frac{r^2}{12} \right)}$$

$$\text{where } r = \frac{(V_{IN} - V_{OUT}) * V_{OUT}}{L * f * I_{OUTMAX} * V_{IN}}$$

(3)

The worst case is when  $V_{IN} = 2 \times V_{OUT}$ .

**Table 11. Suggested Inductors And Their Suppliers**

| MODEL         | VENDOR    | DIMENSIONS L × W × H (mm) | DCR (typical) |
|---------------|-----------|---------------------------|---------------|
| FDSE0312-2R2M | Toko      | 3 × 3 × 1.2               | 160 mΩ        |
| DO1608C-222   | Coilcraft | 6.6 × 4.5 × 1.8           | 80 mΩ         |

### 9.2.2.2.3 Output Capacitor Selection

Use a 10-μF, 6.3-V ceramic capacitor. Use X7R or X5R types, do not use Y5V. DC bias characteristics of ceramic capacitors must be considered when selecting case sizes like 0805 and 0603. DC bias characteristics vary from manufacturer to manufacturer, and DC bias curves should be requested as part of the capacitor selection process. The output filter capacitor smooths out current flow from the inductor to the load, helps maintain a steady output voltage during transient load changes and reduces output voltage ripple. These capacitors must be selected with sufficient capacitance and sufficiently low ESR to perform these functions.

The output voltage ripple is caused by the charging and discharging of the output capacitor and also due to its ESR and can be calculated as:

$$V_{PP-C} = \frac{I_{RIPPLE}}{4 * f * C} \quad (4)$$

Voltage peak-to-peak ripple due to ESR can be expressed as in [Equation 5](#):

$$V_{PP-ESR} = (2 * I_{RIPPLE}) * R_{ESR} \quad (5)$$

Because these two components are out of phase the RMS value can be used to get an approximate value of peak-to-peak ripple.

Voltage peak-to-peak ripple, root mean squared can be expressed as follows:

$$V_{PP-RMS} = \sqrt{V_{PP-C}^2 + V_{PP-ESR}^2} \quad (6)$$

Output voltage ripple is dependent on the inductor current ripple and the equivalent series resistance of the output capacitor ( $R_{ESR}$ ).

The  $R_{ESR}$  is frequency dependent (as well as temperature dependent); make sure the value used for calculations is at the switching frequency of the part.

**Table 12. Suggested Capacitor and Their Suppliers**

| MODEL          | TYPE         | VENDOR      | VOLTAGE | CASE SIZE INCH (mm) |
|----------------|--------------|-------------|---------|---------------------|
| GRM21BR60J106K | Ceramic, X5R | Murata      | 6.3 V   | 0805 (2012)         |
| JMK212BJ106K   | Ceramic, X5R | Taiyo-Yuden | 6.3 V   | 0805 (2012)         |
| C2012X5R0J106K | Ceramic, X5R | TDK         | 6.3 V   | 0805 (2012)         |

### 9.2.2.2.4 Buck Output Ripple Management

If  $V_{IN}$  and  $I_{LOAD}$  increase, the output ripple associated with the buck regulators also increases. [Figure 29](#) shows the safe operating area. To ensure operation in the area of concern, TI recommends that the system designer circumvents the output ripple issues to install Schottky diodes on the buck(s) that are expected to perform under these extreme corner conditions. Schottky diodes are recommended to reduce the output ripple, if system requirements include this shaded area of operation.  $V_{IN} > 1.5$  V and  $I_{LOAD} > 1.24$  A.

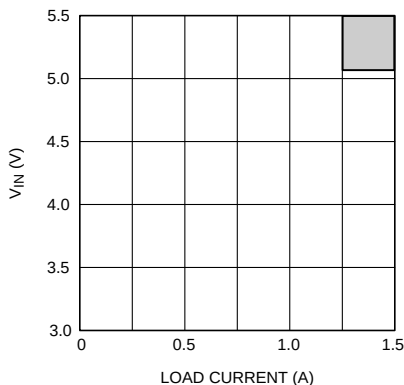
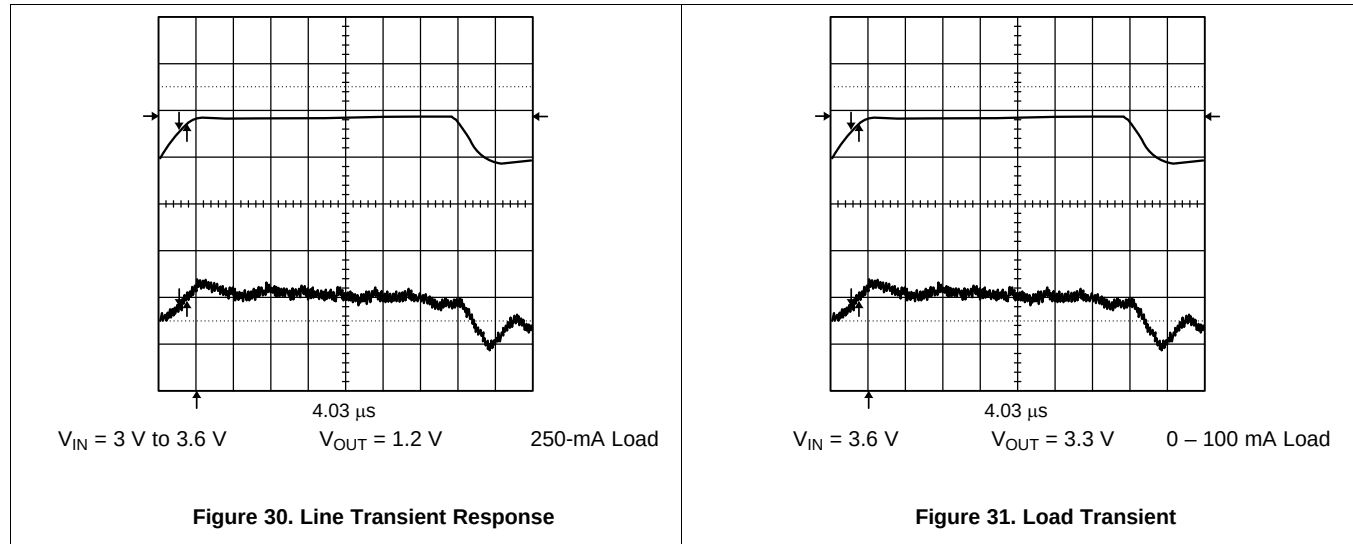


**Figure 29. Application Conditions for Schottky Diodes**

### 9.2.3 Application Curves



## 10 Power Supply Recommendations

The LP3972 is designed to operate from a single-cell lithium-ion battery and a coin-cell backup battery.  $V_{IN}$  input must be between 2.7 V and 5.5 V. The RTC LDO input automatically switches between main and backup batteries at  $V_{IN} > 3\text{ V}$ , and device operational range is  $V_{IN}$  between 3.3 V and 5.5 V. Decoupling capacitance at VIN pin can be shared for all LDO and Buck inputs. It must be placed as close to device as possible.

## 11 Layout

### 11.1 Layout Guidelines

PC board layout is an important part of DC-DC converter design. Poor board layout can disrupt the performance of a DC-DC converter and surrounding circuitry by contributing to EMI, ground bounce, and resistive voltage loss in the traces. These can send erroneous signals to the DC-DC converter device, resulting in poor regulation or instability.

Good layout for the converters can be implemented by following a few simple design rules.

1. Place the converters, inductor and filter capacitors close together and make the traces short. The traces between these components carry relatively high switching currents and act as antennas. Following this rule reduces radiated noise. Special care must be given to place the input filter capacitor very close to the VIN and GND pin.
2. Arrange the components so that the switching current loops curl in the same direction. During the first half of each cycle, current flows from the input filter capacitor through the converter and inductor to the output filter capacitor and back through ground, forming a current loop. In the second half of each cycle, current is pulled up from ground through the converter by the inductor to the output filter capacitor and then back through ground forming a second current loop. Routing these loops so the current curls in the same direction prevents magnetic field reversal between the two half-cycles and reduces radiated noise.
3. Connect the ground pins of the converter and filter capacitors together using generous component-side copper fill as a pseudo-ground plane. Then, connect this to the ground-plane (if one is used) with several vias. This reduces ground-plane noise by preventing the switching currents from circulating through the ground plane. It also reduces ground bounce at the converter by giving it a low-impedance ground connection.
4. Use wide traces between the power components and for power connections to the DC-DC converter circuit. This reduces voltage errors caused by resistive losses across the traces.
5. Route noise sensitive traces, such as the voltage feedback path, away from noisy traces between the power components. The voltage feedback trace must remain close to the converter circuit and must be direct but must be routed opposite to noisy components. This reduces EMI radiated onto the DC-DC converter's own voltage feedback trace. A good approach is to route the feedback trace on another layer and to have a ground plane between the top layer and layer on which the feedback trace is routed. In the same manner for the adjustable part it is desired to have the feedback dividers on the bottom layer.
6. Place noise sensitive circuitry, such as radio RF blocks, away from the DC-DC converter, CMOS digital blocks and other noisy circuitry. Interference with noise-sensitive circuitry in the system can be reduced through distance.

## LP3972

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### 11.2 Layout Example

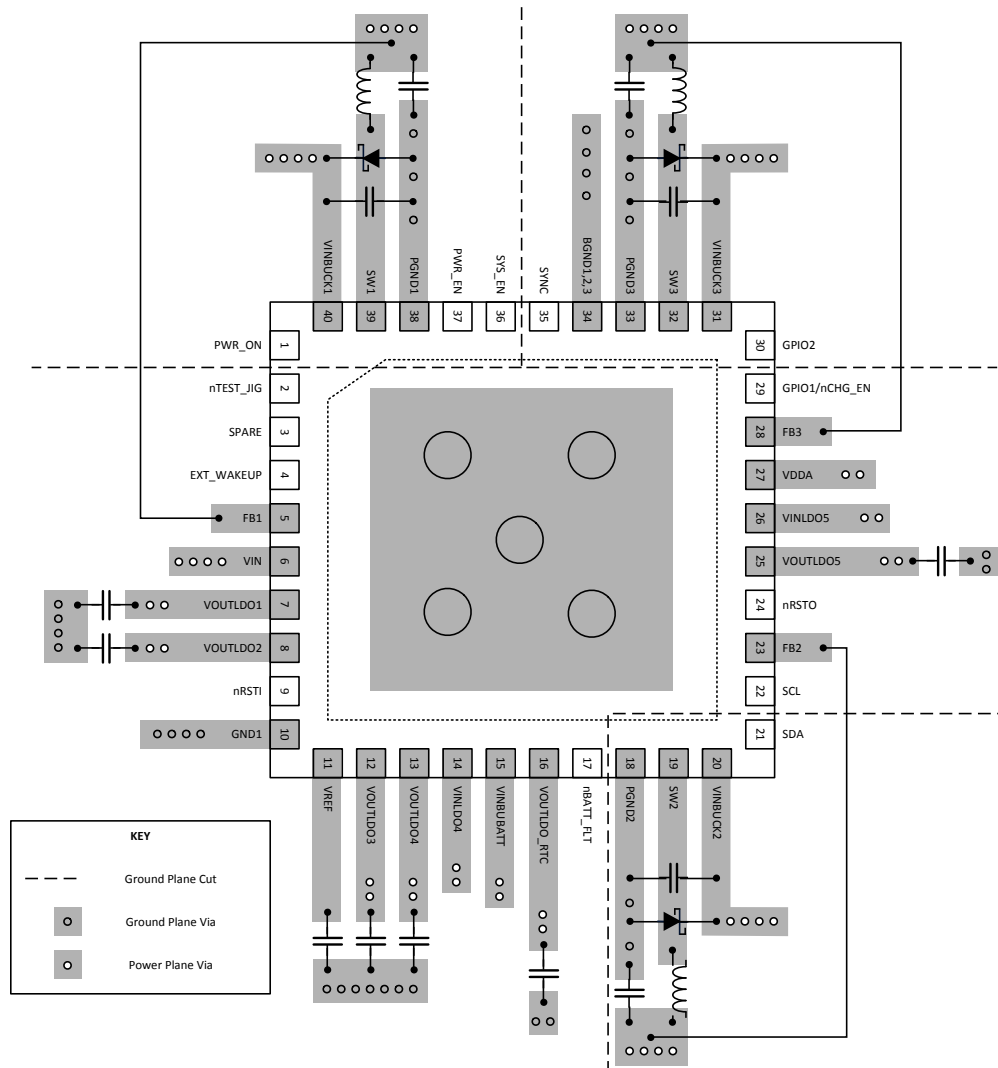


Figure 32. LP3972 Layout

## 12 Device and Documentation Support

### 12.1 Device Support

#### 12.1.1 Third-Party Products Disclaimer

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### 12.2 Related Documentation

For additional information, see the following:

TI Application Note *Leadless Leadframe Package (LLP)* ([SNOA401](#))

### 12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

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**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 12.4 Trademarks

E2E is a trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

### 12.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| LP3972SQ-0514/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | 72-0514             |
| LP3972SQ-0514/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-0514             |
| LP3972SQ-5810/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -            | 72-5810             |
| LP3972SQ-5810/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-5810             |
| LP3972SQ-A413/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-A413             |
| LP3972SQ-A413/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-A413             |
| LP3972SQ-A514/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-A514             |
| LP3972SQ-A514/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-A514             |
| LP3972SQ-E514/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-E514             |
| LP3972SQ-E514/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-E514             |
| LP3972SQ-I414/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-I414             |
| LP3972SQ-I414/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-I414             |
| LP3972SQ-I514/NOPB    | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-I514             |
| LP3972SQ-I514/NOPB.A  | NRND          | Production           | WQFN (RSB)   40 | 1000   SMALL T&R      | Yes         | SN                                   | Level-1-260C-UNLIM                | -40 to 125   | 72-I514             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

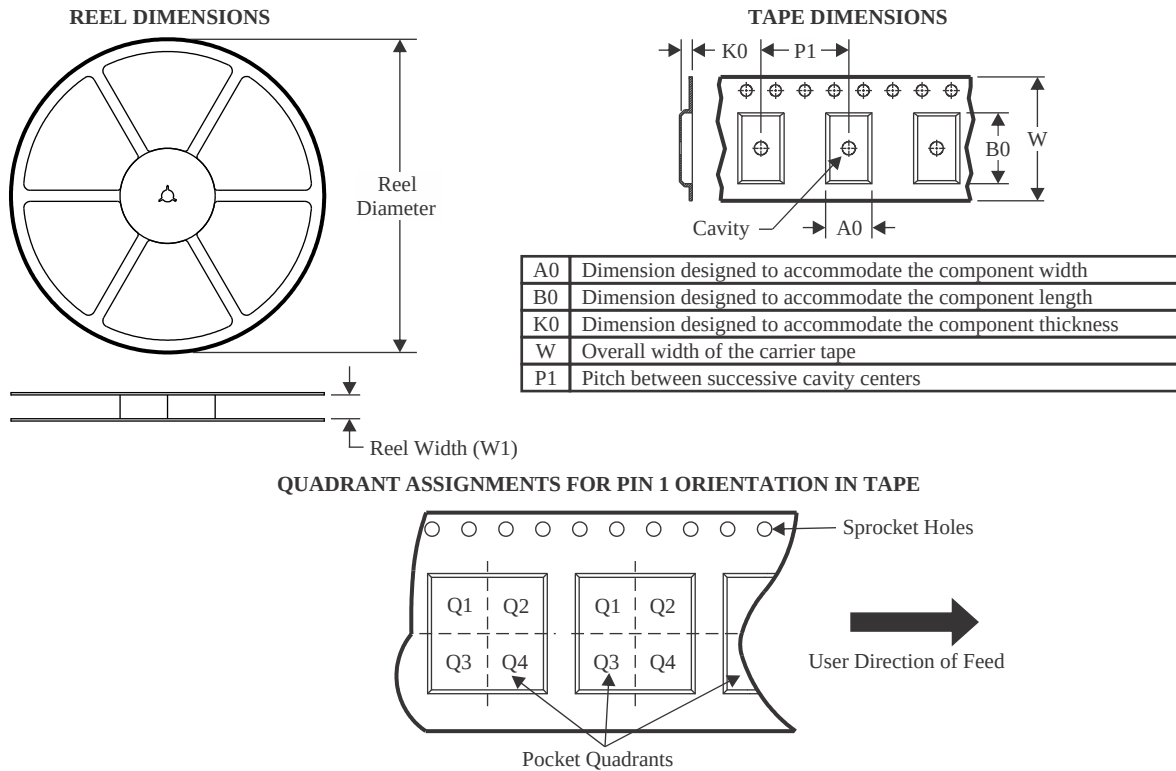
<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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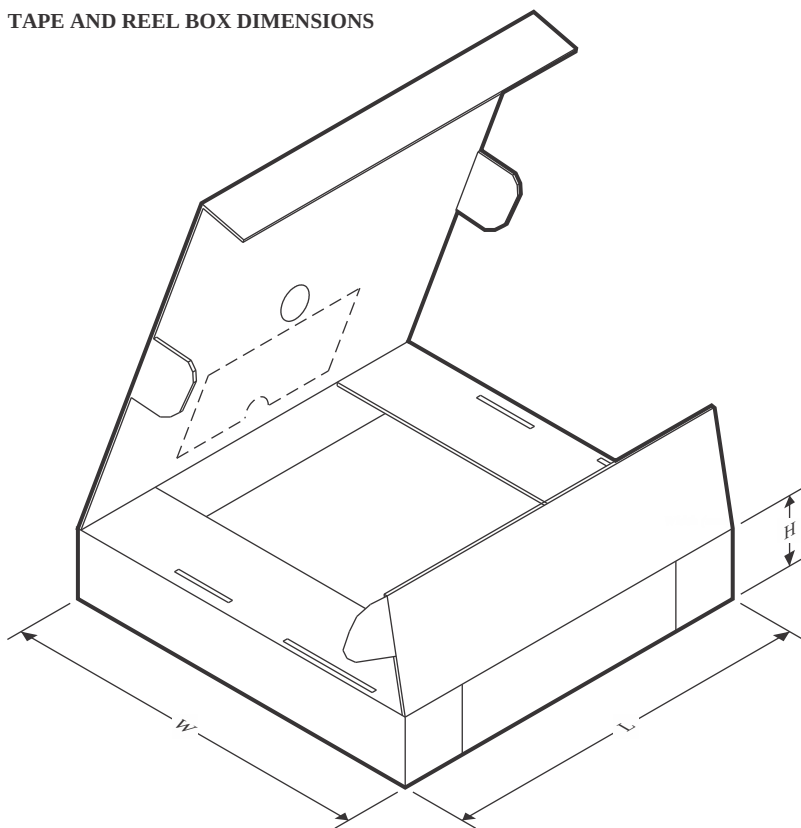
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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LP3972SQ-0514/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LP3972SQ-5810/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LP3972SQ-A413/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LP3972SQ-A514/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LP3972SQ-E514/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LP3972SQ-I414/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LP3972SQ-I514/NOPB | WQFN         | RSB             | 40   | 1000 | 177.8              | 12.4               | 5.3     | 5.3     | 1.3     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LP3972SQ-0514/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |
| LP3972SQ-5810/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |
| LP3972SQ-A413/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |
| LP3972SQ-A514/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |
| LP3972SQ-E514/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |
| LP3972SQ-I414/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |
| LP3972SQ-I514/NOPB | WQFN         | RSB             | 40   | 1000 | 208.0       | 191.0      | 35.0        |

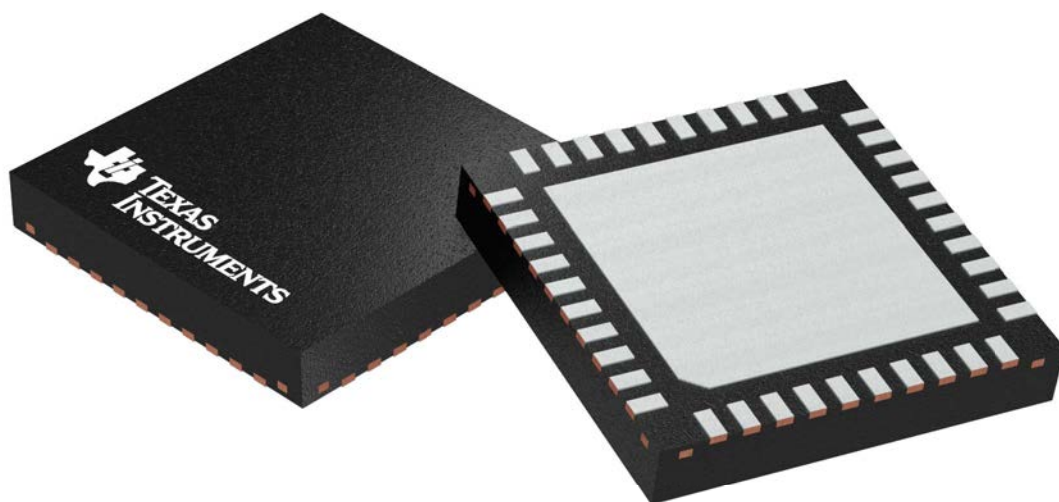
## GENERIC PACKAGE VIEW

**RSB 40**

**WQFN - 0.8 mm max height**

5 x 5 mm, 0.4 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

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